

Intel[®] Server Board S5000VCL

Technical Product Specification

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Revision History

| Date | Revision Number | Modifications | |
|------------|--------------------|---|--|
| Sept. 2006 | 1.0 | Initial release. | |
| Nov. 2006 | 2.0 | dded technical updates and SAS board information. | |
| Jan. 2007 | 2.1 | Removed processor that is not supported by board; added Post-Code Diagnostic LED information. | |
| Sept. 2007 | 2.2 | Updated product codes and processor information. | |
| Jan. 2008 | 2.3 | Updated processor information. | |

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1. Introduction

This Technical Product Specification (TPS) provides board-specific information about the features, functionality, and high-level architecture of the Intel[®] Server Board S5000VCL. See the *Intel[®] 5000 Series Chipsets Server Board Family Datasheet* more information about board subsystems, including chipset, BIOS, system management, and system management software.

There are four product codes of the Intel Server Board S5000VCL:

- SS5000VCL
- S5000VCLSASBB
- BBS5000VCLR
- BBS5000VCLSASR

All references to the Intel[®] Server Board S5000VCL refer to all product codes listed above, unless noted otherwise.

1.1 Server Board Use Disclaimer

Intel Corporation server boards support add-in peripherals and contain high-density VLSI and power delivery components that need adequate airflow to cool. Intel ensures through its own chassis development and testing that when Intel server building blocks are used together, the fully integrated system will meet the intended thermal requirements of these components. It is the responsibility of the system integrator who chooses not to use Intel developed server building blocks to consult vendor datasheets and operating parameters to determine the amount of air flow required for their specific application and environmental conditions. Intel Corporation cannot be held responsible if components fail or the server board does not operate correctly when used outside any of their published operating or non-operating limits.

2. Product Overview

The Intel[®] Server Board S5000VCL is a monolithic printed circuit boards that support the high-density 1U server market.

2.1 Feature Set

| Feature | Description | | | | |
|---|---|--|--|--|--|
| Processors | 771-pin LGA sockets supporting one or two Dual-Core Intel [®] Xeon [®] processors 5100 series, low-voltage Quad-Core [®] Xeon [®] processors 5300 series, and low-voltage Quad-Core [®] Xeon [®] processors 5400 series with system bus speeds of 1066 MHz or 1333 MHz. | | | | |
| | For a complete list of supported processors, see the following link: | | | | |
| | http://support.intel.com/support/motherboards/server/S5000VCL | | | | |
| Memory | Six keyed DIMM slots support fully buffered DIMM technology (FBDIMM) memory. 240- pin DDR2-677 FBDIMMs must be used. | | | | |
| Chipset | Intel [®] 5000V Chipset family, which includes the following components: | | | | |
| | Intel[®] 5000V Memory Controller Hub | | | | |
| | Intel[®] 6321ESB I/O Controller Hub | | | | |
| On-board Connectors / | External connections: | | | | |
| Headers | Stacked PS/2* ports for keyboard and mouse | | | | |
| | Two RJ45 NIC connectors for 10/100/1000 Mb connections | | | | |
| | Two USB 2.0 ports | | | | |
| | Video connector | | | | |
| | Com 1 or Serial A (DB9) | | | | |
| | Internal connectors/headers: | | | | |
| | One USB port header, capable of providing two USB 2.0 ports | | | | |
| | One DH10 Serial B header | | | | |
| | Six SATA ports or four SAS ports via the Intel[®] 6321ESB I/O Controller Hub. These ports support 3Gb/s and integrated SW RAID 0 or 1 | | | | |
| | One 40-pin (power + I/O) ATA/100 connector for optical drive support | | | | |
| | SSI-compliant 24-pin control panel header | | | | |
| | SSI-compliant 24-pin main power connector support the ATX-12 V standard on the first 20 pins | | | | |
| | 8-pin +12 V processor power connector | | | | |
| Add-in PCI, PCI-X*, PCI Express* Cards | One PCI super-slot that will support one 1U riser card with one PCI-X* and one PCI Express* connectors | | | | |
| On-board Video ATI* ES1000 video controller with 16 MB DDR SDRAM | | | | | |
| On-board Hard Drive | Six 3 Gb/s SATA ports, or four SAS ports | | | | |
| Controller | Intel [®] Embedded Server RAID Technology II with RAID levels 0, 1, 10 | | | | |
| LAN | Two 10/100/1000 NICs supporting Intel [®] I/O Acceleration Technology | | | | |
| System Fans | Two CPU 4-pin fan headers supporting two system blowers and one 3-pin fan header supporting a system fan | | | | |
| System Management Support for Intel [®] System Management Software | | | | | |

2.2 Server Board Layout

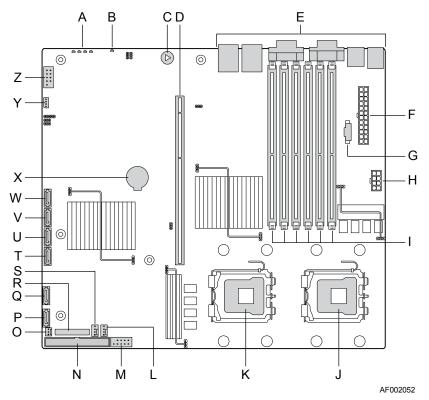
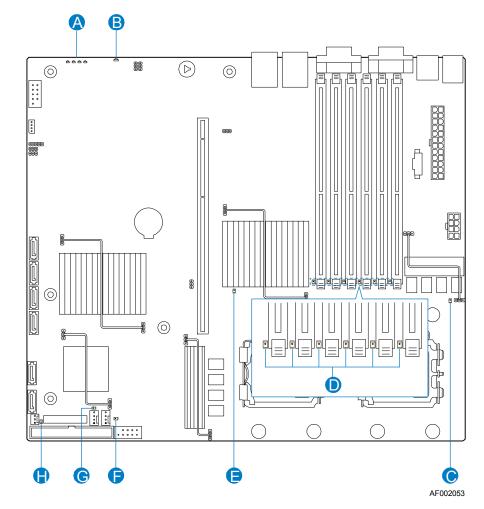


Figure 1. Components and Connector Location Diagram

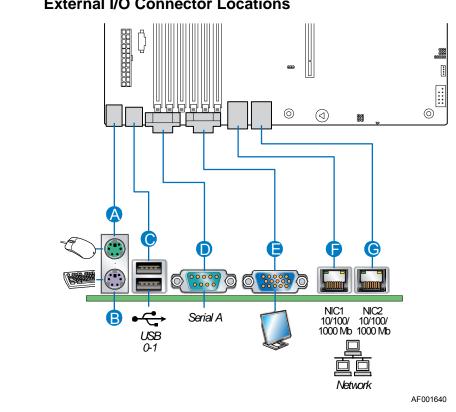
| | Description | | Description |
|---|----------------------------------|-----------|---|
| Α | Post code Diagnostic LEDs | 0 | System Fan Header |
| В | System Fault/Status LED | Р | SATA 0 |
| С | Speaker | Q | SATA 1 |
| D | Super Slot (Slot 6) | R | SSI 24-pin Control Panel Header |
| Е | External IO Connectors | S | CPU 1 Fan Header |
| F | Main Power Connector | Т | SATA 2 / SAS 0 |
| G | Power Supply Auxiliary Connector | U | SATA 3 / SAS 1 |
| Н | CPU Power Connector | V | SATA 4 / SAS 2 |
| Ι | FBDIMM Slots | W | SATA 5 / SAS 3 |
| J | CPU Socket 1 | Х | Battery |
| К | CPU Socket 2 | Y | SATA SGPIO |
| L | CPU 2 Fan Header | Z | Serial B Port Header |
| М | Dual Port USB 2.0 Header | Not shown | SAS GPIO (SAS version of the server board only) |
| Ν | Primary IDE Connector | | |



2.2.1 Intel[®] Light-Guided Diagnostics LED Locations

| | Description | | Description |
|---|---------------------------|---|----------------------|
| А | Post-Code Diagonstic LEDs | Е | CPU 2 Fan Fault LED |
| В | System Fault / Status LED | F | CPU 1 Fan Fault LED |
| С | CPU 1 Fault LED | G | System Fan Fault LED |
| D | DIMM Fault LEDs | Н | 5 VSB LED |
| Е | CPU 2 Fault LED | | |

Figure 2. Intel[®] Light-Guided Diagnostics LED Locations



2.2.2 External I/O Connector Locations

Figure 3. ATX I/O Layout

3. Functional Architecture

The architecture and design of the Intel[®] Server Board S5000VCL is based on the Intel[®] 5000V Chipset. The chipset is for systems based on the Dual-Core Intel[®] Xeon[®] processor 5100 series, low-voltage Quad-Core Intel[®] Xeon[®] processor 5300 series and low-voltage Quad-Core Intel[®] Xeon[®] processor 5400 series with system bus speeds of 1067 MHz and 1333 MHz.

The chipset has two main components: the Intel[®] 5000V Memory Controller Hub (MCH) for the host bridge and the Intel[®] 6321ESB I/O Controller Hub for the I/O subsystem.

This chapter provides a high-level description of the functionality associated with each chipset component and the architectural blocks that make up this server board. For in depth information on each of the chipset components and each of the functional architecture blocks, see the *Intel*[®] *5000 Series Chipsets Server Board Family Datasheet.*

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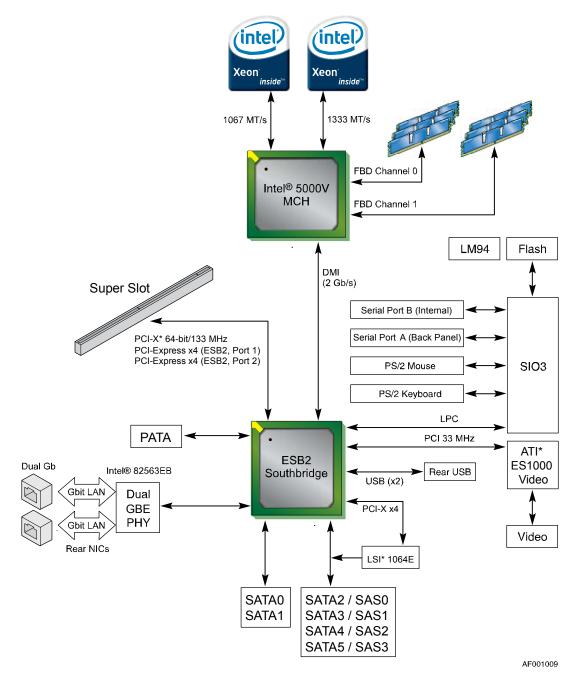


Figure 4. Functional Block Diagram

3.1 Intel[®] 5000V Memory Controller Hub (MCH)

The memory controller hub (MCH) is a single 1432 pin FCBGA package that includes these core platform functions:

- System bus interface for the processor sub-system
- Memory controller
- PCI Express* ports including the enterprise south bridge interface (ESI)
- FBD thermal management
- SMBUS interface

3.1.1 System Bus Interface

The MCH is configured for symmetric multi-processing across two independent front side bus interfaces that connect to the processors. Each front side bus on the MCH uses a 64-bit wide 1066- or 1333-MHz data bus. The 1333-MHz data bus can transfer data at up to 10.66 GB/s. The MCH supports a 36-bit wide address bus, capable of addressing up to 64 GB of memory. The MCH is the priority agent for both front side bus interfaces, and is optimized for one processor on each bus.

3.1.2 Processor Support

The server board supports one or two Dual-Core Intel[®] Xeon[®] processors 5100 series or low voltage Quad-Core Intel[®] Xeon[®] processor 5300 series, or low voltage Quad-Core Intel[®] Xeon[®] processor 5400 series with system bus speeds of 1066 MHz, and 1333 MHz, and core frequencies starting at 1.6 GHz. Previous generations of the Intel[®] Xeon[®] processor are not supported.

For a complete list of supported processors, see the following link: <u>http://support.intel.com/support/motherboards/server/S5000VCL</u>

Note: Only Dual-Core Intel[®] Xeon[®] processors 5100 series or low-voltage Quad-Core Intel[®] Xeon[®] processor 5300 and 5400 series, that support system bus speeds of 1066 MHz, and 1333 MHz are supported.

3.1.2.1 Processor Population Rules

When two processors are installed, both must be of identical revision, core voltage, and bus/core speed. When only one processor is installed, it must be in the socket labeled CPU1. The other socket must be empty.

The board provides up to 90A max, 70A TDC per processor. Processors with higher current requirements are not supported.

3.1.2.2 Common Enabling Kit (CEK) Design Support

The server board complies with Intel's common enabling kit (CEK) processor mounting and heat sink retention solution. The server board ships with a CEK spring snapped onto the underside of the server board, beneath each processor socket. The heat sink attaches to the CEK, over the top of the processor and the thermal interface material (TIM). See the figure below for the stacking order of the chassis, CEK spring, server board, TIM, and heat sink.

The CEK spring is removable, allowing for the use of non-Intel heat sink retention solutions.

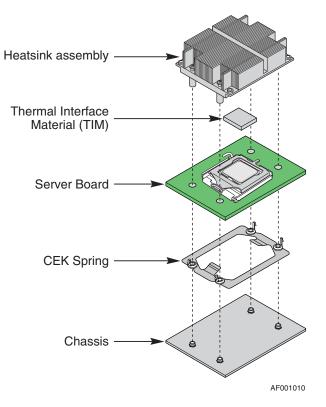


Figure 5. CEK Processor Mounting

Functional Architecture

3.1.3 Memory Sub-system

The MCH masters two fully buffered DIMM (FBDIMM) memory channels. FBDIMM memory utilizes a narrow high-speed frame-oriented interface referred to as a channel. The two channels are routed to six DIMM slots and support registered DDR2-667 FBDIMM memory (stacked or unstacked). Peak FBDIMM memory data bandwidth in dual channel mode is 8.0GB/s (2x4.0 GB/s) with DDR2-667/PC2-5300 (3.0 ns at CL5).

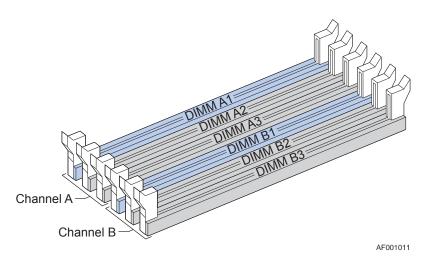


Figure 6. Memory Layout

To boot the system, the system BIOS uses a dedicated I^2C bus to retrieve DIMM information needed to program the MCH memory registers.

| Device | Address |
|---------|---------|
| DIMM A1 | 0xA0 |
| DIMM A2 | 0xA2 |
| DIMM A3 | A4 |
| DIMM B1 | A0 |
| DIMM B2 | A2 |
| DIMM B3 | A4 |

Table 1. I²C Addresses for Memory Module SMB

3.1.3.1 Supported Memory

Up to six DDR2-667 fully-buffered DIMMs (FBD memory) can be installed.

Table 2. Maximum Six-DIMM System Memory Configuration – x4 Single Rank

| DRAM Technology x4 Single Rank | Maximum Capacity Non-Mirrored Mode |
|--------------------------------|---------------------------------------|
| 256 Mb | 1.5 GB |
| 512 Mb | 3 GB |

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| 1024 Mb | 6 GB |
|---------|-------|
| 2048 Mb | 12 GB |

Table 3. Maximum Six-DIMM System Memory Configuration – x8 Dual Rank

| DRAM Technology x8 Dual Rank | Maximum Capacity Non-Mirrored Mode |
|------------------------------|---------------------------------------|
| 256 Mb | 1.5 GB |
| 512 Mb | 3 GB |
| 1024 Mb | 6 GB |
| 2048 Mb | 12 GB |

Note: DDR2 DIMMs that are not fully buffered are NOT supported. See the Intel[®] Server Board S5000VCL Tested Memory List for a list of supported memory.

3.1.3.2 DIMM Population Rules and Supported DIMM Configurations

DIMM population rules depend on the operating mode of the memory controller. The operating mode is determined by the number of DIMMs installed. DIMMs must be populated in pairs in DIMM slot order: A1 & B1, A2 & B2. DIMMs within a pair must be identical with respect to size, speed, and organization, but DIMM capacities can be different across different DIMM pairs.

Note: The server board supports single DIMM mode operation. Intel will only validate and support this configuration with a single 512 MB x8 FBDIMM installed in DIMM slot A1.

3.2 Intel[®] 6321ESB I/O Controller Hub

The Intel[®] 6321ESB I/O Controller Hub is a multi-function device that provides four distinct functions: an IO Controller, a PCI-X* Bridge, a GB Ethernet Controller, and a baseboard management controller (BMC). Each function within the controller hub has its own set of configuration registers. Once configured, each appears to the system as a distinct hardware controller.

The controller hub provides the gateway to all PC-compatible I/O devices and features. The server board uses these Intel[®] 6321ESB I/O Controller Hub features:

- 1. PCI-X* bus interface
- 2. Six channel SATA interface w/SATA busy and fault LED control
- 3. Dual GbE MAC
- 4. Baseboard management controller (BMC)
- 5. Single ATA interface, with Ultra DMA 100 capability
- 6. Universal Serial Bus 2.0 (USB) interface
- 7. Removable media drives
- 8. LPC bus interface
- 9. PC-compatible timer/counter and DMA controllers
- 10. APIC and 8259 interrupt controller
- 11. Power management
- 12. System RTC
- 13. VT technology
- 14. General purpose I/O

For additional information, see the Intel[®] 5000 Series Chipsets Server Board Family Datasheet.

3.2.1 PCI Sub-system

The primary I/O buses support one Super Slot connector, which supports one PCI riser assembly that supports two PCI slots: one low-profile PCI Express* x8, and either a mid-height PCI-X* 133, or one low-profile PCI Express*x4 and one mid-height PCI Express x4. The PCI bus complies with the *PCI Local Bus Specification, Revision 2.3.* The PCI-X bus complies with *PCI-X Local BUS Specification, Revision 2.0,* the PCI Express ports comply with the *PCI Express Base Specification, Revision 1.0a.* PCI 32 supports the VGA ATI* ES1000 video controller.

| Table 4. PCI Bus Segment Char | acteristics |
|-------------------------------|-------------|
|-------------------------------|-------------|

| PCI Bus Segment | Voltage | Width | Speed | Туре | On-board Device Support |
|--------------------------------|-----------|--------|---------|----------|----------------------------|
| PXA | 3.3V/5.0V | 64 bit | 133 MHz | PCI-X* | Full-height riser slot |
| 6321ESB | | | | | |
| PE1, PE2 | 3.3V | x8 | 20 Gb/S | PCI | Low-profile riser slot |
| BNB PCI Express* Ports 4, 5 | | | | Express* | |

3.2.1.1 PXA: 64-bit, 133MHz PCI Subsystem

One 64-bit PCI-X* bus segment is directed through the 6321ESB ICH6. This PCI-X segment, PXA, supports up to three PCI add-in cards on the full-height riser card.

3.2.1.2 PE2: One x4 PCI Express* Bus Segment

One x4 PCI Express* bus segment is directed through the 6321ESB. This PCI Express segment, PE2, supports one x8 PCI Express segment to the proprietary I/O module mezzanine connector.

3.2.1.3 PCI Riser Slot

The primary I/O buses for this server board supports one Super Slot connector which supports one PCI riser assembly supporting two PCI slots:

- One low-profile PCI Express* x8 and one mid-height PCI-X* 133
- Or one low-profile PCI Express*x4 and one mid-height PCI Express* x4.

3.2.2 Serial ATA Support

The Intel[®] 6321ESB I/O Controller Hub has an integrated Serial ATA (SATA) controller that supports independent DMA operation on six ports and supports data transfer rates of up to 3.0 Gb/s. The six SATA ports on the server board are numbered SATA-0 thru SATA-5. The SATA ports can be enabled/disabled and/or configured through the BIOS Setup Utility.

Functional Architecture

3.2.2.1 Intel[®] Embedded Server RAID Technology Support

The embedded Intel[®] Embedded Server RAID Technology solution offers data stripping (RAID Level 0) and data mirroring (RAID Level 1). For higher performance, data stripping alleviates disk bottlenecks by taking advantage of the dual independent DMA engines that each SATA port offers.

Data mirroring is for data security. If a disk fails, a mirrored copied of the failed disk is brought on-line. There is no loss of either PCI resources (request/grant pair) or add-in card slots.

Intel[®] Embedded Server RAID Technology functionality requires these items:

- 15. Intel[®] 6321ESB I/O Controller Hub
- 16. Intel[®] Embedded Server RAID Technology Option ROM
- 17. Intel[®] Application Accelerator RAID edition drivers, most recent revision
- At least two SATA hard disk drives

Intel[®] Embedded Server RAID Technology is not available in these configurations:

- 18. The SATA controller in compatible mode
- Intel[®] Embedded Server RAID Technology has been disabled

3.2.3 Parallel ATA (PATA) Support

The integrated IDE controller of the 6321ESB ICH6 provides one IDE channel. It redefines signals on the IDE cable to allow both host and target throttling of data and transfer rates of up to 100 MB/s. The IDE channel provides optical drive support. The BIOS initializes and supports ATAPI devices such as LS-120/240, CD-ROM, CD-RW and DVD-ROM. The IDE channel is accessed through a high-density 40-pin connector ((J2K5) that provides I/O signals. The ATA channel can be configured and enabled or disabled through the BIOS Setup Utility.

3.2.4 USB 2.0 Support

The USB controller functionality integrated into the 6321ESB provides the interface for up to four USB 2.0 ports. Two external connectors are located on the back edge of the server board and one internal 2x5 header supports two optional USB 2.0 ports.

3.3 Video Support

An ATI* ES1000 PCI graphics accelerator with 16 MB of video DDR SDRAM and support circuitry for an embedded SVGA video sub-system is provided. The ATI ES1000 chip contains an SVGA video controller, clock generator, 2D engine, and RAMDAC in a 359-pin BGA. One 4M x 16 x 4 bank DDR SDRAM chip provides 16 MB of video memory.

The SVGA sub-system supports modes up to 1024×768 resolution in 8 / 16 / 32 bpp modes under 2D. It also supports both CRT and LCD monitors up to a 100 Hz vertical refresh rate.

Video is accessed using a standard 15-pin VGA connector found on the back edge of the server board. Video signals are also made available through the 120-pin bridge-board connector that provides signals for an optional video connector on the control panel. Video is routed to both the

Intel[®] Server Board S5000VCL TPS

rear video connector and a control panel video connector. Video is present at both connectors simultaneously and cannot be disabled at either connector individually. Video monitors can be hot-plugged.

3.3.1.1 Video Modes

The ATI* ES1000 chip supports all standard IBM* VGA modes. The table shows the 2D modes supported for both CRT and LCD.

| 2D Mode | Bofrach Bota (Hz) | 2 | D Video Mode Su | pport |
|-----------|---|-----------|-----------------|-----------|
| 2D Wode | Refresh Rate (Hz) | 8 bpp | 16 bpp | 32 bpp |
| 640x480 | 60, 72, 75, 85, 90, 100, 120, 160, 200 | Supported | Supported | Supported |
| 800x600 | 60, 70, 72, 75, 85, 90, 100, 120, 160 | Supported | Supported | Supported |
| 1024x768 | 60, 70, 72, 75, 85, 90, 100 | Supported | Supported | Supported |
| 1152x864 | 43, 47, 60, 70, 75, 80, 85 | Supported | Supported | Supported |
| 1280x1024 | 60, 70, 74, 75 | Supported | Supported | Supported |
| 1600x1200 | 52 | Supported | Supported | Supported |

Table 5. Video Modes

3.3.1.2 Video Memory Interface

The memory controller sub-system of the ES1000 arbitrates requests from the direct memory interface, the VGA graphics controller, the drawing co-processor, the display controller, the video scalar, and the hardware cursor. Requests are serviced in a manner that ensures display integrity and maximum CPU/co-processor drawing performance.

The server board supports a 16 MB (4 Meg x 16-bit x four banks) DDR SDRAM device for video memory.

3.4 Network Interface Controller (NIC)

Network interface support is provided from the built in Dual GbE MAC features of the 6321ESB in conjunction with the Intel[®] 82563EB compact Physical Layer Transceiver (PHY). Together, they provide support for dual LAN ports designed for 10/100/1000 Mbps operation.

The 82563EB device is based upon proven PHY technology integrated into Intel's gigabit Ethernet controllers. The physical layer circuitry provides a standard IEEE 802.3 Ethernet interface for 1000BASE-T, 100BASE-TX, and 10BASE-T applications (802.3, 802.3u, and 802.3ab). The 82563EB device can transmit and receive data at rates of 1000 Mbps, 100 Mbps, or 10 Mbps.

Functional Architecture

Each network interface controller (NIC) drives two LEDs located on each network interface connector. The link/activity LED at the right of the connector indicates network connection when on, and Transmit/Receive activity when blinking. The speed LED at the left indicates 1000-Mbps operation when amber, 100-Mbps operation when green, and 10-Mbps when off.

| LED Color | LED State | NIC State |
|--------------------|-----------|-----------------------------|
| | Off | 10 Mbps |
| Green/Amber (Left) | Green | 100 Mbps |
| | Amber | 1000 Mbps |
| Green (Right) | On | Active Connection |
| Green (Night) | Blinking | Transmit / Receive activity |

Table 6. NIC2 Status LED

3.4.1 Intel[®] I/O Acceleration Technolgy

Intel[®] I/O Acceleration Technology moves network data efficiently through Intel[®] Xeon[®] processor-based servers for improved application responsiveness across diverse operating systems and virtualized environments.

Intel[®] I/OAT improves network application responsiveness by unleashing the power of Intel[®] Xeon[®] processors through efficient network data movement and reduced system overhead. Intel multi-port network adapters with Intel I/OAT provide high-performance I/O for server consolidation and virtualization via stateless network acceleration that seamlessly scales across multiple ports and virtual machines. Intel I/OAT provides safe and flexible network acceleration through tight integration into popular operating systems and virtual machine monitors, avoiding the support risks of third-party network stacks and preserving existing network requirements such as teaming and failover.

3.5 Super I/O

Legacy I/O support is provided by a National Semiconductor* PC87427 Super I/O device. This chip contains the necessary circuitry to support these functions:

- GPIOs
- Serial ports
- Keyboard and mouse support
- Wake up control
- System health support

3.5.1.1 Serial Ports

The server board provides an external DB9 serial port and an internal serial header.

| RJ45 | Signal | Abbreviation | DB9 |
|------|---------------------|--------------|-------------------|
| 1 | Request to Send | RTS | 7 |
| 2 | Data Terminal Ready | DTR | 4 |
| 3 | Transmitted Data | TD | 3 |
| 4 | Signal Ground | SGND | 5 |
| 5 | Ring Indicator | RI | 9 |
| 6 | Received Data | RD | 2 |
| 7 | DCD or DSR | DCD/DSR | 1 or 6 (see note) |
| 8 | Clear To Send | CTS | 8 |

 Table 7. Serial A Port Header Pin-out (External DB9)

Table 8. Internal Serial B Port Header Pin-out

| Pin | Signal Name | Serial Port A Header Pin-out |
|-----|-------------|------------------------------|
| 1 | DCD | |
| 2 | DSR | |
| 3 | RX | |
| 4 | RTS | 1 ³ 00 4 |
| 5 | ТХ | 5 0 6 |
| 6 | CTS | 7 0 0 8 |
| 7 | DTR | 1 101 |
| 8 | RI | |
| 9 | GND | |

Note: The RJ45-to-DB9 adapter should match the configuration of the serial device used. One of two pin-out configurations is used, depending on whether the serial device requires a DSR or DCD signal. The final adapter configuration should also match the desired pin-out of the RJ45 connector, as it can also be configured to support either DSR or DCD.

3.5.1.2 Floppy Disk Controller

The server board does not support a floppy disk controller (FDC) interface, but the system BIOS recognizes USB floppy devices.

3.5.1.3 Keyboard and Mouse Support

Dual stacked PS/2 ports on the back edge of the server board support a keyboard and mouse. Either port can support a mouse or keyboard. Neither port supports hot plugging.

3.5.1.4 Wake-up Control

The super I/O contains functionality allows events to power-on and power-off the system.

3.5.1.5 System Health Support

The super I/O provides an interface via GPIOs for BIOS and system management firmware to activate the diagnostic LEDs, the FRU fault indicator LEDs for processors, FBDIMMS, fans, and the system status LED. See section 7 to locate the LEDs.

4. Platform Management

The platform management sub-system is based on the integrated baseboard management controller (BMC) features of the Intel[®] 6321ESB I/O Controller Hub. The onboard platform management subsystem consists of communication buses, sensors, system BIOS, and system management firmware.

See Appendix B for onboard sensor data. For additional platform management information see the *Intel[®] 5000 Series Chipsets Server Board Family Datasheet*.

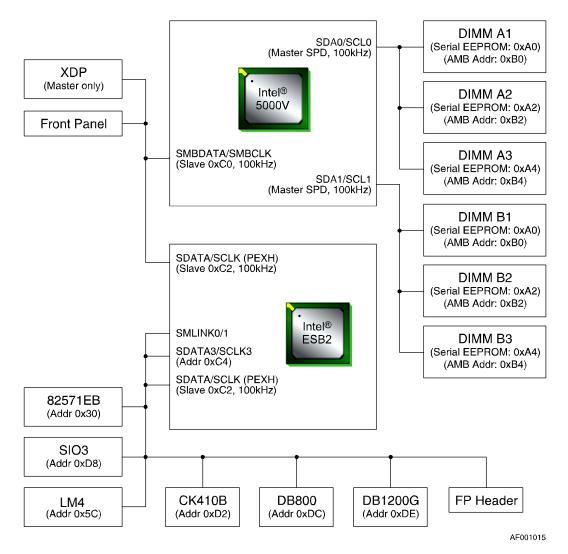


Figure 7. SMBUS Block Diagram

5. Connector / Header Locations and Pin-outs

5.1 Board Connectors

| Connector | Quantity | Server Board Reference Designators | Connector Type | Pin Count |
|------------------------------------|----------|------------------------------------|---|--------------|
| Power supply | 3 | J9E1 | CPU Power | 8 |
| | | J9B1 | Main Power | 24 |
| | | J9C1 | P/S Aux | 5 |
| CPU | 2 | J8H1, J5H1 | CPU Sockets | 771 |
| Main Memory | 8 | J7A2, J7A3, J7A4, J7A5, J8A2, J8A3 | DIMM Sockets | 240 |
| Super Slot | 1 | J4B2 | Card Edge | 98 |
| IDE | 1 | J2K5 | Shrouded Header | 40 |
| CPU Blowers #1 and #2 | 2 | J2K3, J2K4 | Header | 4 |
| System Fan | 2 | J1K1 | Header | 3 |
| Battery | 1 | XBT3E1 | Battery Holder | 3 |
| Keyboard/Mouse | 1 | J9A2 | PS2, stacked | 12 |
| Rear USB | 2 | J9A2 | External | 4 |
| Serial Port A | 1 | J8A1 | External | 9 |
| Serial Port B | 1 | J1A1 | Header | 9 |
| Video connector | 1 | J7A1 | External, D-Sub | 15 |
| LAN connector 10/100/1000 | 2 | JA6A1, JA5A1 | External LAN connector with built-in magnetic | 14 |
| SSI Control Panel | 1 | J2K2 | Header | 24 |
| Internal USB | 1 | J3K1 | Header | 10 |
| Serial ATA (SATA) | 2 | J1J1, J1J2 | Header | 7 |
| SATA/SAS | 4 | J1G2, J1G1, J1F1, J1E4 | Header | 7 |
| System Recovery Setting Jumpers | 4 | J1C2, J1C4 | Jumper | 3 |

Table 9. Board Connector Matrix

5.2 Power Connectors

The main power supply connection is obtained using an SSI compliant 2x12 pin connector (J9B1). Two additional power related connectors; one SSI compliant 2x4 pin power connector (J9E1) supports additional 12V. One SSI compliant 1x5 pin connector (J9C1) provides I^2C monitors the power supply.

| Pin | Signal | Color | Pin | Signal | Color |
|-----|---------|--------|-----|------------|--------|
| 1 | +3.3Vdc | Orange | 13 | +3.3Vdc | Orange |
| 2 | +3.3Vdc | Orange | 14 | -12Vdc | Blue |
| 3 | GND | Black | 15 | GND | Black |
| 4 | +5Vdc | Red | 16 | PS_On# | Green |
| 5 | GND | Black | 17 | GND | Black |
| 6 | +5Vdc | Red | 18 | GND | Black |
| 7 | GND | Black | 19 | GND | Black |
| 8 | PWR_OK | Gray | 20 | RSVD_(-5V) | White |
| 9 | 5VSB | Purple | 21 | +5Vdc | Red |
| 10 | +12Vdc | Yellow | 22 | +5Vdc | Red |
| 11 | +12Vdc | Yellow | 23 | +5Vdc | Red |
| 12 | +3.3Vdc | Orange | 24 | GND | Black |

| Table 10 | . Power | Connector | Pin-out | (J3K3) |
|----------|---------|-----------|---------|--------|
|----------|---------|-----------|---------|--------|

Table 11. 12V Power Connector Pin-out (J9E1)

| Pin | Signal | Color |
|-----|--------|--------------|
| 1 | GND | Black |
| 2 | GND | Black |
| 3 | GND | Black |
| 4 | GND | Black |
| 5 | +12Vdc | Yellow/Black |
| 6 | +12Vdc | Yellow/Black |
| 7 | +12Vdc | Yellow/Black |
| 8 | +12Vdc | Yellow/Black |

| Pin | Signal | Color |
|-----|----------------------|--------|
| 1 | SMB_CLK_ESB_FP_PWR_R | Orange |
| 2 | SMB_DAT_ESB_FP_PWR_R | Black |
| 3 | SMB_ALRT_3_ESB_R | Red |
| 4 | 3.3V SENSE- | Yellow |
| 5 | 3.3V SENSE+ | Green |

Table 12. Power Supply Signal Connector Pin-out (J9C1)

5.3 Riser Card Slots

The server board has one riser card slot. The riser card slot is capable of supporting one riser card that supports one PCI-X* 133 full-height / mid-length add-in card and one low-profile PCI Express* x8 add-in-card.

5.4 SSI Control Panel Connector

The server board provides a 24-pin SSI control panel connector (J2K2) for use with non-Intel chassis. The following table provides the pin-out for this connector.

| Pin | Signal Name | Control Panel Pin-out | Pin | Signal Name |
|-----|---------------|---|-----|------------------|
| 1 | P3V3_STBY | | 2 | P3V3_STBY |
| 3 | Кеу | 0 0 | 4 | P5V_STBY |
| 5 | FP_PWR_LED_L | Power O Cool Fault | 6 | FP_ID_LED_L |
| 7 | P3V3 | HDD 0 0 System | 8 | FP_STATUS_LED1_R |
| 9 | HDD_LED_ACT_R | LED O O System | 10 | FP_STATUS_LED2_R |
| 11 | FP_PWR_BTN_L | Power 0 0 LAN A | 12 | LAN_ACT_A_L |
| 13 | GND | Button O O Link / Act | 14 | LAN_LINKA_L |
| 15 | Reset Button | Reset 0 0 SMBus | 16 | PS_I2C_3VSB_SDA |
| 17 | GND | Button O O Lataular | 18 | PS_I2C_3VSB_SCL |
| 19 | FP_ID_BTN_L | Sleep O O Intruder Button O O LAN B | 20 | FP_CHASSIS_INTRU |
| 21 | TEMP_SENSOR | NMI O O LAN B | 22 | LAN_ACT_B_L |
| 23 | FP_NMI_BTN_L | | 24 | LAN_LINKB_L |
| | | ID LED 0 0 0 0 ID Button 0 0 0 0 | | |

Table 13. Front Panel SSI Standard 24-pin Connector Pin-out (J2K2)

5.5 I/O Connector Pinout Definition

5.5.1 VGA Connector

The following table details the pin-out of the VGA connector (J7A1).

| Pin | Signal Name | Description |
|-----|-----------------|-------------------------------|
| 1 | V_IO_R_COnN | Red (analog color signal R) |
| 2 | V_IO_G_COnN | Green (analog color signal G) |
| 3 | V_IO_B_COnN | Blue (analog color signal B) |
| 4 | TP_VID_COnN_B4 | No connection |
| 5 | GND | Ground |
| 6 | GND | Ground |
| 7 | GND | Ground |
| 8 | GND | Ground |
| 9 | TP_VID_COnN_B9 | No Connection |
| 10 | GND | Ground |
| 11 | TP_VID_COnN_B11 | No connection |
| 12 | V_IO_DDCDAT | DDCDAT |
| 13 | V_IO_HSYNC_COnN | HSYNC (horizontal sync) |
| 14 | V_IO_VSYNC_COnN | VSYNC (vertical sync) |
| 15 | V_IO_DDCCLK | DDCCLK |

| Table 14. | VGA | Connector | Pin-out | (J7A1) |
|-----------|-----|-----------|---------|--------|
|-----------|-----|-----------|---------|--------|

5.5.2 NIC Connectors

The server board provides two RJ45 NIC connectors oriented side-by-side on the back edge of the board (JA6A1, JA5A1). The pin-out for each connector is identical.

| Pin | Signal Name | Pin | Signal Name |
|-----|-------------|---------|-----------------------|
| 1 | GND | 9 | NIC_A_MDI0P |
| 2 | P1V8_NIC | 10 | NIC_A_MDI0N |
| 3 | NIC_A_MDI3P | 11 (D1) | NIC_LINKA_1000_N (LED |
| 4 | NIC_A_MDI3N | 12 (D2) | NIC_LINKA_100_N (LED) |
| 5 | NIC_A_MDI2P | 13 (D3) | NIC_ACT_LED_N |
| 6 | NIC_A_MDI2N | 14 | NIC_LINK_LED_N |
| 7 | NIC_A_MDI1P | 15 | GND |
| 8 | NIC_A_MDI1N | 16 | GND |

5.5.3 IDE Connector

The server board includes an IDE connector that supports a single slimline optical drive such as a CD-ROM or DVD-ROM drive. The connector has 44 pins providing support for both power and I/O singles.

| Pin | Signal Name | Pin | Signal Name |
|-----|-------------------|-----|----------------|
| 1 | ESB_PLT_RST_IDE_N | 2 | GND |
| 3 | RIDE_DD_7 | 4 | RIDE_DD_8 |
| 5 | RIDE_DD_6 | 6 | RIDE_DD_9 |
| 7 | RIDE_DD_5 | 8 | RIDE_DD_10 |
| 9 | RIDE_DD_4 | 10 | RIDE_DD_11 |
| 11 | RIDE_DD_3 | 12 | RIDE_DD_12 |
| 13 | RIDE_DD_2 | 14 | RIDE_DD_13 |
| 15 | RIDE_DD_1 | 16 | RIDE_DD_14 |
| 17 | RIDE_DD_0 | 18 | RIDE_DD_15 |
| 19 | GND | 20 | KEY |
| 21 | RIDE_DDREQ | 22 | GND |
| 23 | RIDE_DIOW_N | 24 | GND |
| 25 | RIDE_DIOR_N | 26 | GND |
| 27 | RIDE_PIORDY | 28 | GND |
| 29 | RIDE_DDACK_N | 30 | GND |
| 31 | IRQ_IDE | 32 | TP_PIDE_32 |
| 33 | RIDE_DA1 | 34 | IDE_PRI_CBLSNS |
| 35 | RIDE_DA0 | 36 | RIDE_DA2 |
| 37 | RIDE_DCS1_N | 38 | RIDE_DCS3_N |
| 39 | LED_IDE_N | 40 | GND |

Table 16. 44-pin IDE Connector Pin-out (J2K5)

5.5.4 SATA Connectors

The server board provides two SATA (Serial ATA) connectors: SATA-0 (J1J2), SATA-1 (J1J1), and four SATA (Serial ATA) / SAS (serial-attached SCSI) connectors: SATA-2 / SAS-0 (J1G2), SATA-3 / SAS-1 (J1G1), SATA-4 / SAS-2 (J1F1), and SATA-5 / SAS-3 (J1E4).

| Pin | Signal Name | Description |
|-----|--------------|---|
| 1 | GND | GND1 |
| 2 | SATA#_TX_P_C | Positive side of transmit differential pair |
| 3 | SATA#_TX_N_C | Negative side of transmit differential pair |
| 4 | GND | GND2 |
| 5 | SATA#_RX_N_C | Negative side of Receive differential pair |
| 6 | SATA#_RX_P_C | Positive side of Receive differential pair |
| 7 | GND | GND3 |

 Table 17. SATA Connector Pin-out (J1J2, J1J1)

| Table 18. SATA / SAS Connector Pin-out (J1G2 | 2, J1G1, J1F1, J1E4) |
|--|----------------------|
|--|----------------------|

| Pin | Signal Name | Description |
|-----|--------------|---|
| 1 | GND | GND1 |
| 2 | SATA#_TX_P_C | Positive side of transmit differential pair |
| 3 | SATA#_TX_N_C | Negative side of transmit differential pair |
| 4 | GND | GND2 |
| 5 | SATA#_RX_N_C | Negative side of Receive differential pair |
| 6 | SATA#_RX_P_C | Positive side of Receive differential pair |
| 7 | GND | GND3 |

5.5.5 Serial Port Connectors

The server board provides one external 9-pin Serial 'A' port (J8A1) and one internal 9-pin Serial B port header (J1A1). The following tables define the pin-outs for each.

| Pin | Signal Name | Description |
|-----|-------------|---------------------------|
| 1 | SPA_DCD | DCD (carrier detect) |
| 2 | SPA_DSR | DSR (data set ready) |
| 3 | SPA_SIN | RXD (receive data) |
| 4 | SPA_CTS | CTS (clear to send) |
| 5 | TP_SPA_RI | RI (Ring Indicate) |
| 6 | SPA_RTS | RTS (request to send) |
| 7 | SPA_SOUT | SOUT (serial out) |
| 8 | SPA_DTR | DTR (Data terminal ready) |
| 9 | GND | Ground |

 Table 19. 9-pin Serial Header Pin-out (J8A1, J1A1)

5.5.6 Keyboard and Mouse Connector

Two stacked PS/2 ports (J9A2) are support both a keyboard and a mouse. Either PS/2 port can support a mouse or a keyboard. The following table details the pin-out of the PS/2 connector.

| Pin | Signal Name | Description |
|-----|-------------|------------------------|
| 1 | KB_DATA_F | Keyboard Data |
| 2 | NC | No Connect |
| 3 | GND | Ground |
| 4 | P5V_KB_F | Keyboard / mouse power |
| 5 | KB_CLK_F | Keyboard Clock |
| 6 | NC | No Connect |
| 7 | MS_DATA_F | Mouse Data |
| 8 | NC | No Connect |
| 9 | GND | Ground |
| 10 | P5V_KB_F | Keyboard / mouse power |
| 11 | MS_CLK_F | Mouse Clock |
| 12 | NC | No Connect |
| 13 | GND | Ground |
| 14 | GND | Ground |
| 15 | GND | Ground |
| 16 | GND | Ground |
| 17 | GND | Ground |

Table 20. Stacked PS/2 Keyboard and Mouse Port Pin-out (J9A2)

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5.5.7 USB Connector

The following table details the pin-out of the external USB connectors (J9A2) found on the back edge of the server board.

| Pin | Signal Name | Description |
|-----|-------------|--|
| 1 | USB_OC1_LAN | USB_Power |
| 2 | USB_P1N_LAN | DATAL1 (Differential data line paired with DATAH1) |
| 3 | USB_P1P_LAN | DATAH1 (Differential data line paired with DATAL1) |
| 4 | GND | Ground |
| 5 | USB_OC0_LAN | USB_Power |
| 6 | USB_P0N_LAN | DATAH0 (Differential data line paired with DATAL0) |
| 7 | USB_P0P_LAN | DATAH0 (Differential data line paired with DATAL0) |
| 8 | GND | Ground |

Table 21. External USB Connector Pin-out (J9A2)

One 2x5 connector on the server board (J3K1) provides an option to support an additional USB 2.0 port.

| Pin | Signal Name | Description |
|-----|-------------|----------------------------|
| 1 | P5V | USB Power |
| 2 | P5V | USB Power |
| 3 | USB_ESB_P5N | USB Port 5 Negative Signal |
| 4 | USB_ESB_P4N | USB Port 4 Negative Signal |
| 5 | USB_ESB_P5P | USB Port 5 Positive Signal |
| 6 | USB_ESB_P4P | USB Port 4 Positive Signal |
| 7 | Ground | Ground |
| 8 | Ground | Ground |
| 9 | | No Pin |
| 10 | NC | No Conncet |

Table 22. Internal USB Connector Pin-out (J3K1)

5.6 Fan Headers

The server board incorporates a system fan circuit that supports two SSI compliant 4-pin fan connectors and one 3-pin connector. The 3-pin connector (J1K1) is for system cooling fans. The two 4-pin fan connectors are for processor cooling fans: CPU1 fan (J2K3) and CPU2 fan (J2K4).

The 4-pin connectors can support CPU fans that draw a maximum of 1.2 amps each. The system fan connectors can be found towards the front edge of the server board, CPU1 fan (J2K3), CPU2 fan (J2K4) and system fan (J1K1). These connectors support a maximum fan load of 3.5 Amps each. With the proper sensor data record (SDR) installed, Intel[®] System Management Software can monitor all system fans in use.

The pin configuration for each fan connector is identical.

| Pin | Signal Name | Туре | Description |
|-----|-------------|-------|--|
| 1 | Ground | GND | GROUND is the power supply ground |
| 2 | 12V | Power | Power supply 12V |
| 3 | Fan Tach | Out | FAN_TACH signal is connected to the BMC to monitor the fan speed |
| 4 | Fan PWM | In | FAN_PWM signal to control fan speed |

Table 23. CPU Fan Connector Pin-out (J2K3, J2K4)

Table 24. PCI Fan Connector Pin-out (J1K1)

| Pin | Signal Name | Туре | Description |
|-----|-------------|-------|--|
| 1 | Ground | GND | GROUND is the power supply ground |
| 2 | 12V | Power | Power supply 12V |
| 3 | Fan Tach | Out | FAN_TACH signal is connected to the BMC to monitor the fan speed |

Note: Intel Corporation server baseboards support peripheral components and contain a number of high-density VLSI and power delivery components that need adequate airflow to cool. Intel's own chassis are designed and tested to meet the intended thermal requirements of these components when the fully integrated system is used together. It is the responsibility of the system integrator that chooses not to use Intel developed server building blocks to consult vendor datasheets and operating parameters to determine the amount of air flow required for their specific application and environmental conditions. Intel Corporation can not be held responsible if components fail or the server board does not operate correctly when used outside any of their published operating or non-operating limits.

6. Jumper Block Settings

The server board has several 3-pin jumper blocks that can be used to configure, protect, or recover specific features of the server board. Pin 1 on each jumper block is denoted by " $\mathbf{\nabla}$ ".

6.1 Recovery Jumper Blocks

| Jumper Name | Pins | What happens at system reset |
|-----------------|------|--|
| J3A1: BMC Force | 1-2 | BMC Firmware Force Update Mode – Disabled (Default) |
| Update | 2-3 | BMC Firmware Force Update Mode – Enabled |
| J1C4: Password | 1-2 | These pins should have a jumper in place for normal system operation. (Default) |
| Clear | 2-3 | If these pins are jumpered, administrator and user passwords will be cleared on the next reset. These pins should not be jumpered for normal operation. |
| J1C2: CMOS | 1-2 | These pins should have a jumper in place for normal system operation. (Default) |
| Clear | 2-3 | If these pins are jumpered, the CMOS settings will be cleared on the next reset. These pins should not be jumpered for normal operation |

Table 25. Recovery Jumpers (J3A1, J1C1, J1C2)

Jumper Block Settings

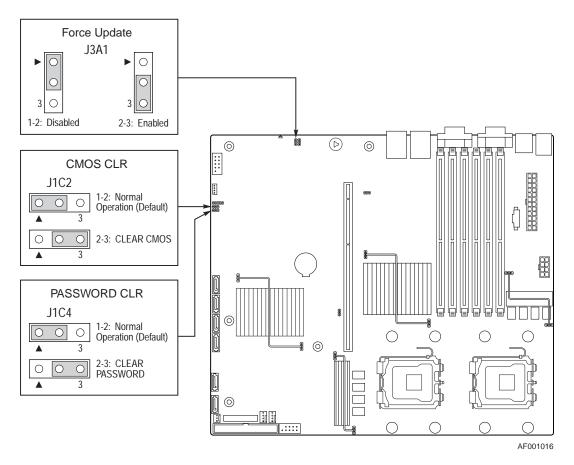


Figure 8. Recovery Jumper Blocks (J3A1, J1C2, J1C4)

6.1.1 CMOS Clear and Password Reset Usage Procedure

The CMOS Clear and Password Reset recovery features are designed for minimal system down time. The usage procedure for these two features has changed from previous generation Intel server boards. The following procedure outlines the new usage model.

- 1. Power down and remove AC power.
- 2. Open server.
- 3. Move jumper from the Default operating position (Pins1-2) to the Reset/Clear position (Pins 2-3).
- 4. Wait 5 seconds.
- 5. Move jumper back to default position (Pins 1-2).
- 6. Close the server chassis.
- 7. Reconnect AC and power up the server.

The password and/or CMOS is cleared and can be reset in BIOS setup.

Intel[®] Server Board S5000VCL TPS

6.1.2 BMC Force Update Procedure

When performing a standard BMC firmware update procedure, the update utility places the BMC into an update mode, allowing the firmware to load safely onto the flash device. In the unlikely event that the BMC firmware update process fails due to the BMC not being in the proper update state, the server board provides a BMC Force Update jumper which will force the BMC into the proper update state. The following procedure should be following in the event the standard BMC firmware update process fails.

- 1. Power down and remove AC power.
- 2. Open the server.
- 3. Move jumper from the Default operating position (pins1-2) to the Enabled position (pins 2-3).
- 4. Close the server chassis.
- 5. Reconnect AC and power up the server.
- 6. Perform the BMC firmware update procedure that is documented in README.TXT file that is included in the given BMC Firmware Update package.
- 7. After successful completion of the firmware update process, the firmware update utility may generate an error stating that the BMC is still in update mode.
- 8. Power down and remove the AC power.
- 9. Open the server.
- 10. Move the jumper from the Enabled position (pins 2-3) to the Disabled position (pins 1-2).
- 11. Close the server chassis.
- 12. Reconnect AC and power up the server.

Note: Normal BMC functionality is disabled with the Force BMC Update jumper set to the "Enabled" position. The server should never be run with the BMC Force Update jumper set in this position and should only be used when the standard firmware update process fails. This jumper should remain in the Default – Disabled position when the server is running normally.

6.2 BIOS Select Jumper

The jumper block located at J3A2, is used to select which BIOS image the system will boot to. Pin 1 on the jumper is identified by ' $\mathbf{\nabla}$ '. This jumper should only be moved to force the BIOS to boot to the secondary bank, which may hold a different version of BIOS.

The rolling BIOS feature of the server board will automatically alternate the Boot BIOS to the secondary bank if the BIOS image in the primary bank is corrupted and cannot boot.

 Table 26. BIOS Select Jumper (J3A2)

| Pins | What happens at system reset |
|------|--|
| 1-2 | Force BIOS to bank 2 |
| 2-3 | System is configured for normal operation (bank 1) (Default) |

6.3 PCIe Select Jumper

The jumper block located at J1E1 is used to select which PCI Express* speed to use. Pin 1 on the jumper is identified by '▼'. This jumper will need to be moved to support the PCI Express speed.

Table 27. PCI Express* x4/x8 Select Jumper (J1E1)

| Pins | Description | | |
|------|------------------------------|--|--|
| 1-2 | PCI Express* two x4 | | |
| 2-3 | PCI Express one x8 (Default) | | |

7. Intel[®] Light Guided Diagnostics

The server board has several on-board diagnostic LEDs to assist in troubleshooting board-level issues. This section shows the location of each LED and provides a high level-usage description. For a more detailed description of what drives the diagnostic LED operation, see the *Intel*[®] *5000 Series Chipsets Server Board Family Datasheet.*

7.1 5-Volt Standby System Status / Fault LED

Several system management features of this server board require that 5-volt standby voltage be supplied from the power supply. The BMC within the 6321ESB, and onboard NICs require this voltage be present when the system is off. The 5-volt Standby System Status LED is illuminated when AC power is applied to the platform and 5-volt standby voltage is supplied to the server board by the power supply. See the figure below to locate this LED.

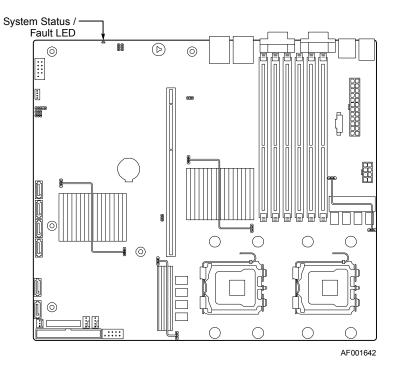


Figure 9. System Status / Fault LED Location

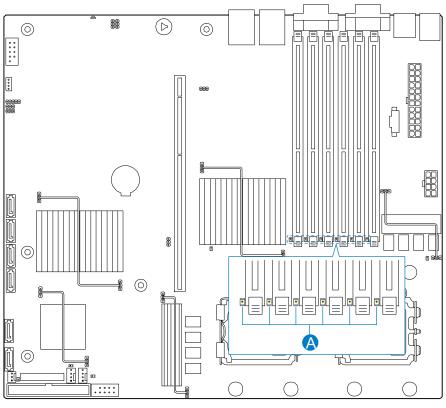
When the AC power is first applied to the system and 5-volt standby is present, the BMC on the server board requires 15-20 seconds to initialize. During this time, the system status LED blinks amber and green, and the power button functionality is disabled, preventing the server from powering up. Once BMC initialization has completed, the status LED will stop blinking and the power button functionality is restored and can be used to turn on the server.

| Color | State | Criticality | Description |
|------------------|----------------------|----------------|---|
| Off | N/A | Not ready | AC power off |
| Green / Amber | Alternating Blink | Not ready | Pre-DC power on – 15-20 second BMC initialization when AC is applied to the server. Control Panel buttons are disabled until the BMC initialization is complete. |
| Green | Solid on | System OK | System booted and ready. |
| Green | Blink | Degraded | System degraded |
| | | | Unable to use all of the installed memory (more than one DIMM installed). |
| | | | Correctable errors over a threshold of 10 and migrating to a spare DIMM (memory sparing). This indicates that the user no longer has spared DIMMs indicating a redundancy lost condition. Corresponding DIMM LED should light up. |
| | | | In mirrored configuration, when memory mirroring takes place and system loses memory redundancy. This is not covered by the bullet above. |
| | | | Redundancy loss such as power-supply or fan. This does not apply to non-redundant sub-systems. |
| | | | PCI-e link errors |
| | | | CPU failure / disabled – if there are two processors and one of them fails |
| | | | Fan alarm – Fan failure. Number of operational fans should be more than minimum number needed to cool the system |
| | | | Non-critical threshold crossed – Temperature and voltage |
| Amber | Blink | Non-critical | Non-fatal alarm – system is likely to fail |
| | | | Critical voltage threshold crossed |
| | | | VRD hot asserted |
| | | | Minimum number of fans to cool the system not present or failed |
| | | | In non-sparing and non-mirroring mode if the threshold of ten correctable errors is crossed within the window |
| Amber | Solid on | Critical, non- | Fatal alarm – system has failed or shutdown |
| | | recoverable | DIMM failure when there is one DIMM present, no good memory present |
| | | | Run-time memory uncorrectable error in non-redundant mode |
| | | | IERR signal asserted |
| | | | Processor 1 missing |
| | | | Temperature (CPU ThermTrip, memory TempHi, critical threshold crossed) |
| | | | No power good – power fault |
| | | | Processor configuration error (for instance, processor stepping mismatch) |

The bi-color 5V Standby System Status LED operates as follows:

7.2 DIMM LEDs

The server board provides a memory fault LED for each DIMM slot. The DIMM fault LED is illuminated when the system BIOS disables the specified DIMM after it reaches a specified number of given failures or if specific critical DIMM failures are detected. See the *Intel*[®] 5000 Series Chipsets Server Board Family Datasheet.



AF001525

Figure 10. DIMM LED Locations

7.3 Post Code Diagnostic LEDs

During the system boot process, BIOS executes a number of platform configuration processes, each of which is assigned a specific hex POST code number. As each configuration routine is started, BIOS will display the given POST code to the POST Code Diagnostic LEDs found on the back edge of the server board. To assist in troubleshooting a system hang during the POST process, the Diagnostic LEDs can be used to identify the last POST process to be executed. See Appendix C for a complete description of how these LEDs are read, and for a list of all supported POST codes.

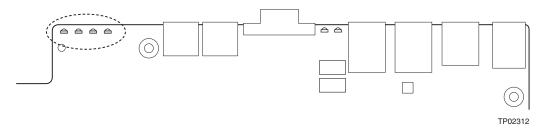


Figure 11. POST Code Diagnostic LED Location

8. Power and Environmental Specifications

8.1 Intel[®] Server Board S5000VCL Design Specifications

Operating the server board at conditions beyond those shown in the table may cause permanent damage to the system. Exposure to absolute maximum rating conditions for extended periods may affect system reliability.

| Operating Temperature | 0° C to 55° C ¹ (32° F to 131° F) |
|---|--|
| Non-Operating Temperature | -40° C to 70° C (-40° F to 158° F) |
| DC Voltage | ± 5% of all nominal voltages |
| Shock (Unpackaged) | Trapezoidal, 50 g, 170 inches/sec |
| Shock (Packaged) | |
| < 20 lbs | 36 inches |
| ≥ 20 to < 40 | 30 inches |
| ≥ 40 to < 80 | 24 inches |
| ≥ 80 to < 100 | 18 inches |
| ≥100 to < 120 | 12 inches |
| ≥120 | 9 inches |
| Vibration (Unpackaged) | 5 Hz to 500 Hz 3.13 g RMS random |
| Operating Temperature | 5° C to 50° C ¹ (32° F to 131° F) |
| Non-Operating Temperature | -40° C to 70° C (-40° F to 158° F) |
| DC Voltage | ± 5% of all nominal voltages |
| Shock (Unpackaged) | Trapezoidal, 50 g, 170 inches/sec |
| Shock (Packaged) (≥ 40 lbs to < 80 lbs) | 24 inches |
| Vibration (Unpackaged) | 5 Hz to 500 Hz 3.13 g RMS random |

Table 28. Server Board Design Specifications

Note:

¹ The chassis design must provide proper airflow to avoid exceeding the Dual-Core Intel[®] Xeon[®] processor 5100 series or Quad-Core Intel[®] Xeon[®] processor 5300 series maximum case temperature.

Disclaimer Note: Intel Corporation server boards support add-in peripherals and contain a number of high-density VLSI and power delivery components that need adequate airflow to cool. Intel ensures through its own chassis development and testing that when Intel server building blocks are used together, the fully integrated system will meet the intended thermal requirements of these components. It is the responsibility of the system integrator who chooses not to use Intel developed server building blocks to consult vendor datasheets and operating parameters to determine the amount of air flow required for their specific application and environmental conditions. Intel Corporation cannot be held responsible, if components fail or the server board does not operate correctly when used outside any of their published operating or non-operating limits.

8.2 Baseboard Power Requirements

This section provides power supply design guidelines for a system using the Intel[®] Server Board S5000VCL, including voltage and current specifications and power supply on/off sequencing characteristics.

8.2.1 Processor Power Support

The server board supports the Thermal Design Point (TDP) guideline for Dual-Core Intel[®] Xeon[®] processors 5100 series and Quad-Core Intel[®] Xeon[®] processor 5300 series. The Flexible Motherboard Guidelines (FMB) has also been followed to help determine the suggested thermal and current design values for anticipating future processor needs. The following table provides maximum values for Icc, TDP power and T_{CASE} for the Dual-Core Intel[®] Xeon[®] processor 5100 series family and Quad-Core Intel[®] Xeon[®] processor 5300 series family.

Table 29. Dual-Core Intel® Xeon® processor 5100 series and Quad-Core Intel® Xeon® processor5300 series TDP Guidelines

| TDP Power | Max TCASE | Icc MAX |
|-----------|-----------|---------|
| 108 W | 70° C | 90 A |

Note: These values are for reference only. The Dual-Core Intel[®] Xeon[®] processor 5100 series and Quad-Core Intel[®] Xeon[®] processor 5300 series Datasheet *contains the actual specifications for the processor. If the values found in the* Dual-Core Intel[®] Xeon[®] processor 5100 series Datasheet *are different than those published here, the* Dual-Core Intel[®] Xeon[®] processor 5100 series Datasheet *values will supersede these, and should be used.*

8.2.2 **Power Supply Output Requirements**

This section is for reference purposes only. Its intent is to provide guidance to system designers for determining a proper power supply for use with this server board. The contents of this section specify the power supply requirements Intel used to develop a power supply for its 1U server system.

The following table defines power and current ratings for this 400 W power supplies. The combined output power of all outputs shall not exceed the rated output power. The power supply must meet both static and dynamic voltage regulation requirements for the minimum loading conditions.

| Voltage | Minimum Continuous | Maximum Continuous | Peak |
|---------------------|--------------------|--------------------|-------|
| +3.3 V ¹ | 1.5 A | 10 A | |
| +5 V ¹ | 1.0 A | 20 A | |
| +12 V ² | 0.5 A | 16 A | 18 A |
| +12 V ³ | 0.5 A | 16 A | 18 A |
| +12 V ⁴ | 0.5 A | 16 A | |
| +12 V ⁵ | 0.5 A | 16 A | |
| -12 V | 0 A | 0.5 A | |
| +5 VSB | 0.1 A | 3.0 A | 3.5 A |

Table 30. 400W Load Ratings

Notes:

- 1. Combined 3.3 V and 5 V power shall not exceed 100 W.
- 2. Maximum continuous total DC output power should not exceed 400 W.
- 3. Peak load on the combined 12 V output shall not exceed 49 A.
- 4. Maximum continuous load on the combined 12 V output shall not exceed 44 A.
- 5. Peak total DC output power should not exceed 650 W.
- 6. Peak power and current loading shall be supported for a minimum of 12 seconds.

8.2.3 Turn On No Load Operation

At power on the system shall present a no load condition to the power supply. In this no load state the voltage regulation limits for the 3.3V and 5V are relaxed to +/-10% and the +12V rails relaxed to +10/-8%. When operating loads are applied the voltages must regulated to there normal limits.

| Voltage | Minimum Continuous | Maximum Continuous | Peak |
|--------------------|--------------------|--------------------|-------|
| +3.3 V | 0 A | 7 A | |
| +5 V | 0 A | 5 A | |
| +12 V ¹ | 0 A | 5 A | 7 A |
| +12 V ² | 0 A | 5 A | 7 A |
| +12 V ³ | 0 A | 6 A | |
| +12 V ⁴ | 0 A | 5 A | |
| -12 V | 0 A | 0.5 A | |
| +5 VSB | 0.1 A | 3.0 A | 3.5 A |

Table 31. No-load Operating Range

Notes:

- 1. Maximum continuous total DC output power should not exceed 400 W.
- 2. Peak load on the combined 12 V output shall not exceed 49 A.
- 3. Maximum continuous load on the combined 12 V output shall not exceed 44 A.
- 4. Peak total DC output power should not exceed 650 W.

8.2.4 Grounding

The grounds of the pins of the power supply output connector provide the power return path. The output connector ground pins shall be connected to safety ground (power supply enclosure). **This grounding should be well designed to ensure passing the maximum allowed common mode noise levels.**

The power supply shall be provided with a reliable protective earth ground. All secondary circuits shall be connected to protective earth ground. Resistance of the ground returns to chassis shall not exceed 1.0 m Ω . This path may be used to carry DC current.

8.2.5 Standby Outputs

The 5 VSB output shall be present when an AC input greater than the power supply turn on voltage is applied.

8.2.6 Remote Sense

The power supply has remote sense return (ReturnS) to regulate out ground drops for all output voltages: +3.3 V, +5 V, +12 V1, +12 V2, +12 V3, -12 V, and 5 VSB. The power supply uses remote sense (3.3 VS) to regulate out drops in the system for the +3.3 V output. The +5 V, +12 V1, +12 V2, +12 V3, -12 V and 5 VSB outputs only use remote sense referenced to the ReturnS signal.

The remote sense input impedance to the power supply must be greater than 200 Ω on 3.3 VS and 5 VS; this is the value of the resistor connecting the remote sense to the output voltage internal to the power supply. Remote sense must be able to regulate out a minimum of a 200 mV drop on the +3.3 V output.

The remote sense return (ReturnS) must be able to regulate out a minimum of a 200 mV drop in the power ground return. The current in any remote sense line shall be less than 5 mA to prevent voltage sensing errors. The power supply must operate within specification over the full range of voltage drops from the power supply's output connector to the remote sense points.

8.2.7 Voltage Regulation

The power supply output voltages must stay within the following voltage limits when operating at steady state and dynamic loading conditions. These limits include the peak-peak ripple/noise.

| Parameter | Tolerance | Minimum | Nominal | Maximum | Units |
|-----------|------------|---------|---------|---------|------------------|
| + 3.3V | - 5% / +5% | +3.14 | +3.30 | +3.46 | V _{rms} |
| + 5V | - 5% / +5% | +4.75 | +5.00 | +5.25 | V _{rms} |
| + 12V | - 5% / +5% | +11.40 | +12.00 | +12.60 | V _{rms} |
| - 12V | - 5% / +9% | -11.40 | -12.00 | -13.08 | V _{rms} |
| + 5VSB | - 5% / +5% | +4.75 | +5.00 | +5.25 | V _{rms} |

| Table 32. | Voltage | Regulation | Limits |
|-----------|---------|------------|--------|
|-----------|---------|------------|--------|

Intel[®] Server Board S5000VCL TPS

8.2.8 Dynamic Loading

The output voltages shall remain within limits for the step loading and capacitive loading specified in the table below. The load transient repetition rate shall be tested between 50 Hz and 5 kHz at duty cycles ranging from 10%-90%. The load transient repetition rate is only a test specification. The Δ step load may occur anywhere within the MIN load to the MAX load conditions.

| Output | ∆ Step Load Size (See note 2) | Load Slew Rate | Test Capacitive Load |
|--------|----------------------------------|----------------|-------------------------|
| +3.3 V | 6.0 A | 0.25 A/µsec | 250 μF |
| +5 V | 4.0 A | 0.25 A/µsec | 400 μF |
| 12 V | 18.0 A | 0.25 A/µsec | 2200 μF ^{1, 2} |
| +5 VSB | 0.5 A | 0.25 A/µsec | 20 μF |

Table 33. Transient Load Requirements

Notes:

1. Step loads on each 12 V output may happen simultaneously.

2. The +12 V should be tested with 2200 μ F evenly split between the four +12 V rails.

8.2.9 Capacitive Loading

The power supply shall be stable and meet all requirements with the following capacitive loading ranges.

| Output | Minimum | Maximum | Units |
|--------|----------|---------|-------|
| +3.3 V | 250 | 6,800 | μF |
| +5 V | 400 | 4,700 | μF |
| +12 V | 500 each | 11,000 | μF |
| -12 V | 1 | 350 | μF |
| +5 VSB | 20 | 350 | μF |

Table 34. Capacitive Loading Conditions

8.2.10 Closed-Loop Stability

The power supply shall be unconditionally stable under all line/load/transient load conditions including capacitive load ranges. A minimum of: 45 degrees phase margin and -10 dB gain margin is required. The power supply manufacturer shall provide proof of the unit's closed-loop stability with local sensing through the submission of bode plots. Closed-loop stability must be ensured at the maximum and minimum loads as applicable.

8.2.11 Common Mode Noise

The common mode noise on any output shall not exceed 350 mV pk-pk over the frequency band of 10 Hz to 30 MHz.

Power and Environmental Specifications

- The measurement shall be made across a 100 Ω resistor between each of the DC outputs, including ground, at the DC power connector and chassis ground (power subsystem enclosure).
- The test set-up shall use an FET probe such as Tektronix* model P6046 or equivalent. •

8.2.12 **Ripple / Noise**

The maximum allowed ripple/noise output of the power supply is defined in the following table. This is measured over a bandwidth of 0 Hz to 20 MHz at the power supply output connectors. A 10 µF tantalum capacitor in parallel with a 0.1 µF ceramic capacitor are placed at the point of measurement.

Table 35. Ripple and Noise

| ĺ | +3.3 V | +5 V | +12 V | -12 V | +5 VSB |
|---|---------|---------|----------|----------|---------|
| | 50mVp-p | 50mVp-p | 120mVp-p | 120mVp-p | 50mVp-p |

8.2.13 Soft Starting

The power supply shall contain a control circuit which provides a monotonic soft start for its outputs without overstress of the AC line or any power supply components at any specified AC line or load conditions. There is no requirement for rise time on the 5 V standby, but the turn on/off shall be monotonic.

8.2.14 **Timing Requirements**

These are the timing requirements for the power supply operation. The output voltages must rise from 10% to within regulation limits (T_{vout rise}) within 5 to 70 ms, except for 5VSB; it is allowed to rise from 1.0 to 25 ms. All outputs must rise monotonically. Each output voltage shall reach regulation within 50 ms (T_{vout on}) of each other during turn on of the power supply. Each output voltage shall fall out of regulation within 400 msec (T_{vout off}) of each other during turn off. The following diagrams show the timing requirements for the power supply being turned on and off via the AC input with PSOn held low, and the PSOn signal with the AC input applied.

Table 36. Output Voltage Timing

| ltem | Description | Minimum | Maximum | Units |
|------------------------|--|---------|---------|-------|
| T _{vout rise} | Output voltage rise time from each main output. | 5.0 * | 70 * | msec |
| T _{vout_on} | All main outputs must be within regulation of each other within this time. | | 50 | msec |
| T _{vout off} | All main outputs must leave regulation within this time. | | 400 | msec |

The 5 VSB output voltage rise time shall be from 1.0 ms to 25.0 ms

Intel[®] Server Board S5000VCL TPS

Power and Environmental Specifications

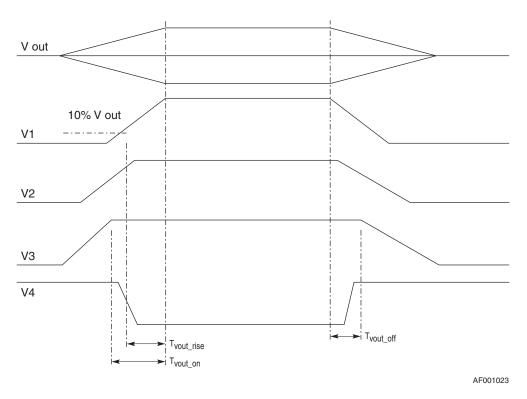


Figure 12. Output Voltage Timing

| Table | 37 | Turn | On/Off | Timing |
|-------|-----|---------|---------|---------|
| Table | 57. | i ui ii | 011/011 | rinning |

| Item | Description | Minimum | Maximum | Units |
|--------------------------|---|---------|---------|-------|
| T _{sb_on_delay} | Delay from AC being applied to 5VSB being within regulation. | | 1500 | msec |
| $T_{ac_on_delay}$ | Delay from AC being applied to all output voltages being within regulation. | | 2500 | msec |
| T_{vout_holdup} | Time all output voltages stay within regulation after loss of AC. Measured at 75% of maximum load. | 21 | | msec |
| T_{pwok_holdup} | Delay from loss of AC to de-assertion of PWOK. Measured at 75% of maximum load. | 20 | | msec |
| $T_{pson_on_delay}$ | Delay from PSOn [#] active to output voltages within regulation limits. | 5 | 400 | msec |
| T _{pson_pwok} | Delay from PSOn [#] deactive to PWOK being de-asserted. | | 50 | msec |
| T _{pwok_on} | Delay from output voltages within regulation limits to PWOK asserted at turn on. | 100 | 500 | msec |
| T pwok_off | Delay from PWOK de-asserted to output voltages (3.3V, 5V, 12V, -12V) dropping out of regulation limits. | 1 | | msec |
| T _{pwok_low} | Duration of PWOK being in the de-asserted state during an off/on cycle using AC or the PSOn signal. | 100 | | msec |
| T _{sb_vout} | Delay from 5VSB being in regulation to O/Ps being in regulation at AC turn on. | 50 | 1000 | msec |
| T_{5VSB} holdup | Time the 5VSB output voltage stays within regulation after loss of AC. | 70 | | msec |

Power and Environmental Specifications

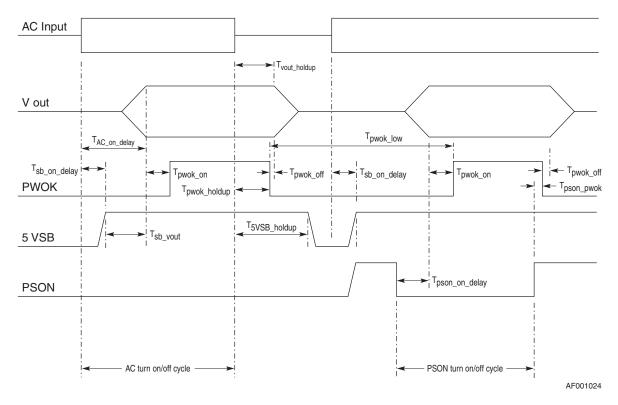


Figure 13. Turn On/Off Timing (Power Supply Signals)

8.2.15 Residual Voltage Immunity in Standby Mode

The power supply shall be immune to any residual voltage placed on its outputs (typically a leakage voltage through the system from standby output) up to 500 mV. There shall be no additional heat generated, nor stress of any internal components with this voltage applied to any individual output, and all outputs simultaneously. It also should not trip the power supply protection circuits during turn on.

Residual voltage at the power supply outputs for a no load condition shall not exceed 100 mV when AC voltage is applied and the PSOn# signal is de-asserted.

9. Regulatory and Certification Information

To ensure regulatory compliance, you must adhere to the assembly instructions in this guide to ensure and maintain compliance with existing product certifications and approvals. Use only the described, regulated components specified in this guide. Use of other products / components will void the UL listing and other regulatory approvals of the product and will most likely result in noncompliance with product regulations in the region(s) in which the product is sold.

To help ensure EMC compliance with your local regional rules and regulations, before computer integration, make sure that the chassis, power supply, and other modules have passed EMC testing using a server board with a microprocessor from the same family (or higher) and operating at the same (or higher) speed as the microprocessor used on this server board. The final configuration of your end system product may require additional EMC compliance testing. For more information please contact your local Intel Representative.

This is an FCC Class A device. Integration of it into a Class B chassis does not result in a Class B device.

9.1 **Product Regulatory Compliance**

Intended Application – This product was evaluated as Information Technology Equipment (ITE), which may be installed in offices, schools, computer rooms, and similar commercial type locations. The suitability of this product for other product categories and environments (such as: medical, industrial, telecommunications, NEBS, residential, alarm systems, test equipment, etc.), other than an ITE application, may require further evaluation. This is an FCC Class A device. Integration of it into a Class B chassis does not result in a Class B device.

9.1.1 Product Safety Compliance

- UL60950 CSA 60950 (USA / Canada)
- EN60950 (Europe)
- IEC60950 (International)
- CB Certificate & Report, IEC60950 (report to include all country national deviations)
- GOST R 50377-92 Listed on one System License (Russia)
- Belarus License Listed on System License (Belarus)
- CE Low Voltage Directive 73/23/EEE (Europe)
- IRAM Certification (Argentina)

9.1.2 **Product EMC Compliance – Class A Compliance**

- FCC /ICES-003 Emissions (USA/Canada) Verification
- CISPR 22 Emissions (International)
- EN55022 Emissions (Europe)
- EN55024 Immunity (Europe)
- CE EMC Directive 89/336/EEC (Europe)
- VCCI Emissions (Japan)
- AS/NZS 3548 Emissions (Australia / New Zealand)
- BSMI CNS13438 Emissions (Taiwan)
- GOST R 29216-91 Emissions Listed on one System License (Russia)
- GOST R 50628-95 Immunity –Listed on one System License (Russia)
- Belarus License Listed on one System License (Belarus)
- RRL MIC Notice No. 1997-41 (EMC) & 1997-42 (EMI) (Korea)

9.1.3 Certifications / Registrations / Declarations

- UL Certification or NRTL (US/Canada)
- CE Declaration of Conformity (CENELEC Europe)
- FCC/ICES-003 Class A Attestation (USA/Canada)
- C-Tick Declaration of Conformity (Australia)
- MED Declaration of Conformity (New Zealand)
- BSMI Certification (Taiwan)
- GOST Listed on one System License (Russia)
- Belarus Listed on one System License (Belarus)
- RRL Certification (Korea)
- Ecology Declaration (International)

9.2 Product Regulatory Compliance Markings

The server board is provided with the following regulatory marks.

| Regulatory Compliance | Region | Marking |
|------------------------|---------------------------|---|
| UL Mark | USA/Canada | |
| CE Mark | Europe | CE |
| EMC Marking (Class A) | Canada | CANADA ICES-003 CLASS A CANADA NMB-003 CLASSE A |
| BSMI Marking (Class A) | Taiwan | Θ |
| | | 警告使用者: 這是甲類的資訊產品,在居住的環境中使用時, 可能會造成射頻干擾,在這種情況下,使用者會 被要求採取某些適當的對策 |
| C-tick Marking | Australia / New Zealand | C |
| RRL MIC Mark | Korea | |
| Country of Origin | Exporting Requirements | MADE IN xxxxx (Provided by label, not silk screen) |
| Model Designation | Regulatory Identification | Examples (Intel [®] Server Board S5000VCL) for boxed type boards; or Board PB number for non- boxed boards (typically high-end boards) |

9.3 Electromagnetic Compatibility Notices

9.3.1 FCC Verification Statement (USA)

This device complies with Part 15 of the FCC Rules. Operation is subject to two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Intel Corporation 5200 N.E. Elam Young Parkway Hillsboro, OR 97124-6497 Phone: 1-800-628-8686

This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to Part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of these measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and the receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

Any changes or modifications not expressly approved by the grantee of this device could void the user's authority to operate the equipment. The customer is responsible for ensuring compliance of the modified product.

All cables used to connect to peripherals must be shielded and grounded. Operation with cables, connected to peripherals that are not shielded and grounded may result in interference to radio and TV reception.

9.3.2 ICES-003 (Canada)

Cet appareil numérique respecte les limites bruits radioélectriques applicables aux appareils numériques de Classe B prescrites dans la norme sur le matériel brouilleur: "Appareils Numériques", NMB-003 édictée par le Ministre Canadian des Communications.

English translation of the notice above:

This digital apparatus does not exceed the Class B limits for radio noise emissions from digital apparatus set out in the interference-causing equipment standard entitled "Digital Apparatus," ICES-003 of the Canadian Department of Communications.

9.3.3 Europe (CE Declaration of Conformity)

This product has been tested in accordance too, and complies with the Low Voltage Directive (73/23/EEC) and EMC Directive (89/336/EEC). The product has been marked with the CE Mark to illustrate its compliance.

9.3.4 VCCI (Japan)

この装置は、情報処理装置等電波障害自主規制協議会(VCCI)の基準 に基づくクラスB情報技術装置です。この装置は、家庭環境で使用すること を目的としていますが、この装置がラジオやテレビジョン受信機に近接して 使用されると、受信障害を引き起こすことがあります。 取扱説明書に従って正しい取り扱いをして下さい。

English translation of the notice above:

This is a Class B product based on the standard of the Voluntary Control Council for Interference (VCCI) from Information Technology Equipment. If this is used near a radio or television receiver in a domestic environment, it may cause radio interference. Install and use the equipment according to the instruction manual.

9.3.5 BSMI (Taiwan)

The BSMI Certification Marking and EMC warning is located on the outside rear area of the product.

警告使用者: 這是甲類的資訊產品,在居住的環境中使用時, 可能會造成射頻干擾,在這種情況下,使用者會 被要求採取某些適當的對策

9.3.6 RRL (Korea)

Following is the RRL certification information for Korea.



English translation of the notice above:

- 1. Type of Equipment (Model Name): On License and Product
- 2. Certification No.: On RRL certificate. Obtain certificate from local Intel representative
- 3. Name of Certification Recipient: Intel Corporation
- 4. Date of Manufacturer: Refer to date code on product
- 5. Manufacturer/Nation: Intel Corporation/Refer to country of origin marked on product

9.3.7 CNCA (CCC-China)

The CCC Certification Marking and EMC warning is located on the outside rear area of the product.

声明

此为A级产品,在生活环境中,该产品可能会造成无 线电干扰。在这种情况下,可能需要用户对其干扰采 取可行的措施。

9.4 Restriction of Hazardous Substances (RoHS) Compliance

Intel has a system in place to restrict the use of banned substances in accordance with the European Directive 2002/95/EC. Compliance is based on declaration that materials banned in the RoHS Directive are either (1) below all applicable substance threshold limits or (2) an approved/pending RoHS exemption applies.

Note: RoHS implementing details are not fully defined and may change.

Threshold limits and banned substances are noted below.

- Quantity limit of 0.1% by mass (1000 PPM) for:
 - Lead
 - Mercury
 - Hexavalent Chromium
 - Polybrominated Biphenyls Diphenyl Ethers (PBDE)
- Quantity limit of 0.01% by mass (100 PPM) for:
 - Cadmium

Appendix A: Integration and Usage Tips

- When adding or removing components or peripherals from the server board, AC power must be removed. With AC power plugged into the server board, 5-volt standby is still present even though the server board is powered off.
- When two processors are installed, both must be of identical revision, core voltage, and bus/core speed. Mixed processor steppings is supported. However, the stepping of one processor can not be greater then one stepping back of the other.
- Processors must be installed in order. CPU 1 is located near the edge of the server board and must be populated to operate the board.
- Only fully buffered DIMMs (FBD) are supported on this server board. For a list of supported memory for this server board, see the Intel[®] Server Board S5000VCL Tested Memory List.
- For a list of Intel supported operating systems, add-in cards, and peripherals for this server board, see the *Intel[®] Server Board S5000VCL Tested Hardware and OS List.*
- Only Dual-Core Intel[®] Xeon[®] processors 5100 series or low- voltage Quad-Core Intel[®] Xeon[®] processor 5300 series, with system bus speeds of 1066, or 1333 MHz are supported on this server board. Previous generation Intel[®] Xeon[®] processors are not supported.
 - For a complete list of supported processors, see the following link: <u>http://support.intel.com/support/motherboards/server/S5000VCL</u>
- Removing AC power before performing the CMOS clear operation will cause the system to automatically power up and immediately power down after the procedure is followed and AC power is re-applied. If this happens remove the AC power cord again, wait 30 seconds, and then reconnect the AC power cord. Power up the system and proceed to the <F2> BIOS setup utility to reset desired settings.
- Normal BMC functionality is disabled with the force BMC update jumper set to the "enabled" position (pins 2-3). The server should never be run with the BMC force update jumper set in this position and should only be used when the standard firmware update process fails. This jumper should remain in the default (disabled) position (pins 1-2) when the server is running normally.
- When performing a BIOS update, the BIOS select jumper must be set to its default position (pins 2-3).

Intel order number: D64569-007

Appendix B: Sensor Tables

This appendix lists the sensor identification numbers and information regarding the sensor type, name, supported thresholds, assertion and de-assertion information, and a brief description of the sensor purpose. See the *Intelligent Platform Management Interface Specification, Version 1.5*, for sensor and event/reading-type table information.

Sensor Type

The Sensor Type references the values enumerated in the *Sensor Type Codes* table in the IPMI specification. It provides the context in which to interpret the sensor, e.g., the physical entity or characteristic that is represented by this sensor.

• Event / Reading Type

The Event/Reading Type references values from the *Event/Reading Type Code Ranges* and *Generic Event/Reading Type Codes* tables in the *IPMI specification*. Note that digital sensors are a specific type of discrete sensors, which have only two states.

• Event Offset/Triggers

Event Thresholds are 'supported event generating thresholds' for threshold types of sensors.

- [u,l][nr,c,nc] upper nonrecoverable, upper critical, upper noncritical, lower nonrecoverable, lower critical, lower noncritical
- uc, lc upper critical, lower critical

Event Triggers are 'supported event generating offsets' for discrete type sensors. The offsets can be found in the *Generic Event/Reading Type Codes* or *Sensor Type Codes* tables in the IPMI specification, depending on whether the sensor event/reading type is generic or a sensor specific response.

• Assertion / De-assertion Enables

Assertion and de-assertion indicators reveal the type of events the sensor can generate:

- As: Assertions
- De: De-assertion

Readable Value / Offsets

- Readable Value indicates the type of value returned for threshold and other nondiscrete type sensors.
- Readable Offsets indicate the offsets for discrete sensors that are readable via the *Get Sensor Reading* command. Unless otherwise indicated, all event triggers are readable, i.e., *Readable Offsets* consists of the reading type offsets that do not generate events.

Appendix B: Sensor Tables

• Event Data

This is the data that is included in an event message generated by the associated sensor. For threshold-based sensors, these abbreviations are used:

- R: Reading value
- T: Threshold value
- Rearm Sensors
 - The rearm is a request for the event status for a sensor to be rechecked and updated upon a transition between good and bad states. Rearming the sensors can be done manually or automatically. This column indicates the type supported by the sensor. The following abbreviations are used in the comment column to describe a sensor:

A: Auto-rearm

M: Manual rearm

• Default Hysteresis

- Hysteresis setting applies to all thresholds of the sensor. This column provides the count of hysterisis for the sensor, which can be 1 or 2 (positive or negative hysteresis).

• Criticality

- Criticality is a classification of the severity and nature of the condition. It also controls the behavior of the Control Panel Status LED.

• Standby

- Some sensors operate on standby power. These sensors may be accessed and / or generate events when the main (system) power is off, but AC power is present.

Appendix C: POST Error Messages and Handling

Whenever possible, the BIOS will output the current boot progress codes on the video screen. Progress codes are 32-bit quantities plus optional data. The 32-bit numbers include class, subclass, and operation information. The class and subclass fields point to the type of hardware that is being initialized. The operation field represents the specific initialization activity. Based on the data bit availability to display progress codes, a progress code can be customized to fit the data width. The higher the data bit, the higher the granularity of information that can be sent on the progress port. The progress codes may be reported by the system BIOS or option ROMs.

The Response section in the table is divided into two types:

- **Pause:** The message is displayed in the Error Manager screen, an error is logged to the SEL, and user input is required to continue. The user can take immediate corrective action or choose to continue booting.
- **Halt:** The message is displayed in the Error Manager screen, an error is logged to the SEL, and the system cannot boot unless the error is resolved. The user needs to replace the faulty part and restart the system.

| Error Code | Error Message | Response |
|------------|---|----------|
| 004C | Keyboard / interface error | Pause |
| 0012 | CMOS date / time not set | Pause |
| 5220 | Configuration cleared by jumper | Pause |
| 5221 | Passwords cleared by jumper | Pause |
| 5223 | Configuration default loaded | Pause |
| 0048 | Password check failed | Halt |
| 0141 | PCI resource conflict | Pause |
| 0146 | Insufficient memory to shadow PCI ROM | Pause |
| 8110 | Processor 01 internal error (IERR) on last boot | Pause |
| 8111 | Processor 02 internal error (IERR) on last boot | Pause |
| 8120 | Processor 01 thermal trip error on last boot | Pause |
| 8121 | Processor 02 thermal trip error on last boot | Pause |
| 8130 | Processor 01 disabled | Pause |
| 8131 | Processor 02 disabled | Pause |
| 8160 | Processor 01 unable to apply BIOS update | Pause |
| 8161 | Processor 02 unable to apply BIOS update | Pause |
| 8190 | Watchdog timer failed on last boot | Pause |
| 8198 | Operating system boot watchdog timer expired on last boot | Pause |
| 0192 | L3 cache size mismatch | Halt |
| 0194 | CPUID, processor family are different | Halt |
| 0195 | Front side bus mismatch | Pause |
| 0197 | Processor speeds mismatched | Pause |
| 8300 | Baseboard management controller failed self-test | Pause |
| 8306 | Front panel controller locked | Pause |

Table 38. POST Error Messages and Handling

Appendix C: POST Error Messages and Handling

Intel[®] Server Board S5000VCL TPS

| Error Code | Error Message | Response |
|------------|---|----------|
| 8305 | Hotswap controller failed | Pause |
| 84F2 | Baseboard management controller failed to respond | Pause |
| 84F3 | Baseboard management controller in update mode | Pause |
| 84F4 | Sensor data record empty | Pause |
| 84FF | System event log full | Pause |
| 8500 | Memory Component could not be configured in the selected RAS mode. | Pause |
| 8520 | DIMM_A1 failed Self Test (BIST). | Pause |
| 8521 | DIMM_A2 failed Self Test (BIST). | Pause |
| 8522 | DIMM_A3 failed Self Test (BIST). | Pause |
| 8523 | DIMM_A4 failed Self Test (BIST). | Pause |
| 8524 | DIMM_B1 failed Self Test (BIST). | Pause |
| 8525 | DIMM_B2 failed Self Test (BIST). | Pause |
| 8526 | DIMM_B3 failed Self Test (BIST). | Pause |
| 8527 | DIMM_B4 failed Self Test (BIST). | Pause |
| 8528 | DIMM_C1 failed Self Test (BIST). | Pause |
| 8529 | DIMM_C2 failed Self Test (BIST). | Pause |
| 852A | DIMM_C3 failed Self Test (BIST). | Pause |
| 852B | DIMM_C4 failed Self Test (BIST). | Pause |
| 852C | DIMM_D1 failed Self Test (BIST). | Pause |
| 852D | DIMM D2 failed Self Test (BIST). | Pause |
| 852E | DIMM_D3 failed Self Test (BIST). | Pause |
| 852F | DIMM_D4 failed Self Test (BIST). | Pause |
| 8540 | Memory Component lost redundancy during the last boot. | Pause |
| 8580 | DIMM A1 Correctable ECC error encountered. | Pause |
| 8581 | DIMM_A2 Correctable ECC error encountered. | Pause |
| 8582 | DIMM_A3 Correctable ECC error encountered. | Pause |
| 8583 | DIMM_A4 Correctable ECC error encountered. | Pause |
| 8584 | DIMM_B1 Correctable ECC error encountered. | Pause |
| 8585 | DIMM B2 Correctable ECC error encountered. | Pause |
| 8586 | DIMM B3 Correctable ECC error encountered. | Pause |
| 8587 | DIMM B4 Correctable ECC error encountered. | Pause |
| 8588 | DIMM_C1 Correctable ECC error encountered. | Pause |
| 8589 | DIMM C2 Correctable ECC error encountered. | Pause |
| 858A | DIMM C3 Correctable ECC error encountered. | Pause |
| 858B | DIMM C4 Correctable ECC error encountered. | Pause |
| 858C | DIMM_D1 Correctable ECC error encountered. | Pause |
| 858D | DIMM_D2 Correctable ECC error encountered. | Pause |
| 858E | DIMM_D3 Correctable ECC error encountered. | Pause |
| 858F | DIMM_D4 Correctable ECC error encountered. | Pause |
| 8600 | Primary and secondary BIOS IDs do not match. | Pause |
| 8601 | Override jumper is set to force boot from lower alternate BIOS bank of flash ROM | Pause |
| 8602 | WatchDog timer expired (secondary BIOS may be bad!) | Pause |
| 8603 | Secondary BIOS checksum fail | Pause |

Intel[®] Server Board S5000VCL TPS

POST Error Beep Codes

The following table lists POST error beep codes. Prior to system video initialization, the BIOS uses these beep codes to inform users on error conditions. The beep code is followed by a user visible code on POST Progress LEDs.

Table 39. POST Error Beep Codes

| Beeps | Error Message | POST Progress Code | Description |
|-------|----------------------------|--------------------|--|
| 3 | Memory error | | System halted because a fatal error related to the memory was detected. |
| 6 | BIOS rolling back error | | The system has detected a corrupted BIOS in the flash part, and is rolling back to the last good BIOS. |

The BMC may generate beep codes upon detection of failure conditions. Beep codes are sounded each time the problem is discovered, such as on each power-up attempt, but are not sounded continuously. Codes that are common across all Intel[®] server boards and systems that use the Intel[®] 5000 Series Chipsets are listed in Table 40. Each digit in the code is represented by a sequence of beeps whose count is equal to the digit.

Table 40. BMC Beep Codes

| Code | Reason for Beep | Associated Sensors | Supported? |
|---------|---|---|------------|
| 1-5-2-1 | CPU: Empty slot / population error – Processor slot 1 is not populated. | CPU Population Error | Yes |
| 1-5-2-2 | CPU: No processors (terminators only) | N/A | No |
| 1-5-2-3 | CPU: Configuration error (e.g., VID mismatch) | N/A | No |
| 1-5-2-4 | CPU: Configuration error (e.g., BSEL mismatch) | N/A | No |
| 1-5-4-2 | Power fault: DC power unexpectedly lost (power good dropout) | Power Unit – power unit failure offset | Yes |
| 1-5-4-3 | Chipset control failure | N/A | No |
| 1-5-4-4 | Power control fault | Power Unit – soft power control failure offset | Yes |

Appendix D: POST Code Diagnostic LED Decoder

During the system boot, the BIOS executes platform configuration processes, each of which is assigned a specific hex POST code number. As each configuration routine is started, the BIOS displays the POST code on the POST Code Diagnostic LEDs on the back edge of the server board. The Diagnostic LEDs identify the last POST process to be executed.

Each POST code is represented by a combination of colors from the four LEDs. The LEDs are capable of displaying three colors: green, red, and amber. The POST codes are divided into an upper nibble and a lower nibble. Each bit in the upper nibble is represented by a red LED and each bit in the lower nibble is represented by a green LED. If both bits are set in the upper and lower nibbles then both the red and green LEDs are lit, resulting in an amber color. If both bits are clear, then the LED is off.

Example: The BIOS sends a value of ACh to the diagnostic LED decoder. The LEDs are decoded as:

- red bits = 1010b = Ah
- green bits = 1100b = Ch

Since the red bits correspond to the upper nibble and the green bits correspond to the lower nibble, the two are concatenated as ACh.

| | 8h | | 4h | | 2h | | 1h | |
|--------|-------|-------|-------|-------|-----|-------|-----|-------|
| LEDs | Red | Green | Red | Green | Red | Green | Red | Green |
| ACh | 1 | 1 | 0 | 1 | 1 | 0 | 0 | 0 |
| Result | Amber | | Green | | Red | | Off | |
| | MSB | | | | | | LS | SB |

Table 41. Example POST Progress Code LED

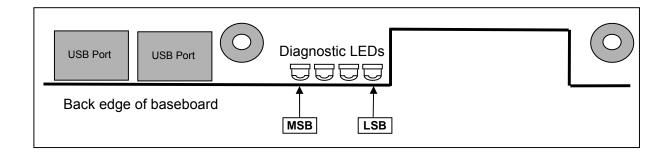


Figure 14. Diagnostic LED Placement Diagram

Intel[®] Server Board S5000VCL TPS

| | Diagnostic LED Decoder | | | Description | |
|------------------------------------|------------------------|-----|-----|-------------|---|
| Checkpoint G=Green, R=Red, A=Amber | | | | | |
| MSB LSB | | | | | LSB |
| | | | OFF | Б | Dower on initialization of the best processor (bestatran processor) |
| 0x10h | OFF | OFF | | R | Power-on initialization of the host processor (bootstrap processor) |
| 0x11h | OFF | OFF | OFF | A | Host processor cache initialization (including AP) |
| 0x12h | OFF | OFF | G | R | Starting application processor initialization |
| 0x13h | OFF | OFF | G | A | SMM initialization |
| Chipset | 0" | 0.5 | | | |
| 0x21h | Off | Off | R | G | Initializing a chipset component |
| Memory | 0" | 0.0 | | 011 | |
| 0x22h | Off | Off | A | Off | Reading configuration data from memory (SPD on DIMM) |
| 0x23h | Off | Off | A | G | Detecting presence of memory |
| 0x24h | Off | G | R | Off | Programming timing parameters in the memory controller |
| 0x25h | Off | G | R | G | Configuring memory parameters in the memory controller |
| 0x26h | Off | G | A | Off | Optimizing memory controller settings |
| 0x27h | Off | G | A | G | Initializing memory, such as ECC init |
| 0x28h | G | Off | R | Off | Testing memory |
| PCI Bus | | | | | |
| 0x50h | Off | R | Off | R | Enumerating PCI busses |
| 0x51h | Off | R | Off | Α | Allocating resources to PCI busses |
| 0x52h | Off | R | G | R | Hot Plug PCI controller initialization |
| 0x53h | Off | R | G | Α | Reserved for PCI bus |
| 0x54h | Off | Α | Off | R | Reserved for PCI bus |
| 0x55h | Off | Α | Off | Α | Reserved for PCI bus |
| 0x56h | Off | Α | G | R | Reserved for PCI bus |
| 0x57h | Off | Α | G | Α | Reserved for PCI bus |
| USB | | | | | |
| 0x58h | G | R | Off | R | Resetting USB bus |
| 0x59h | G | R | Off | Α | Reserved for USB devices |
| ATA / ATAPI | / SATA | | | | |
| 0x5Ah | G | R | G | R | Resetting PATA / SATA bus and all devices |
| 0x5Bh | G | R | G | A | Reserved for ATA |
| SMBUS | I | I | L | I | 1 |
| 0x5Ch | G | Α | Off | R | Resetting SMBUS |
| 0x5Dh | G | A | Off | Α | Reserved for SMBUS |
| Local Conso | le | 1 | I | I | 1 |
| 0x70h | Off | R | R | R | Resetting the video controller (VGA) |
| 0x71h | Off | R | R | A | Disabling the video controller (VGA) |
| 0x72h | Off | R | A | R | Enabling the video controller (VGA) |
| Remote Con | | 1 | | - | |
| 0x78h | G | R | R | R | Resetting the console controller |
| 0x79h | G | R | R | A | Disabling the console controller |
| 0x7Ah | G | R | A | R | Enabling the console controller |
| 0/1/11 | | | ~~~ | | |

Table 42. Diagnostic LED POST Code Decoder

Revision 2.3

Appendix D: POST Code Diagnostic LED Decoder

Intel[®] Server Board S5000VCL TPS

| Diagnostic LED Decode | | oder | Description | | |
|-----------------------|-------------------------|----------|-------------|-----|---|
| Checkpoint | G=Green, R=Red, A=Amber | | | | |
| | MSB | | | LSB | |
| Keyboard (P | | - | ~ " | | |
| 0x90h | R | Off | Off | R | Resetting the keyboard |
| 0x91h | R | Off | Off | A | Disabling the keyboard |
| 0x92h | R | Off | G | R | Detecting the presence of the keyboard |
| 0x93h | R | Off | G | A | Enabling the keyboard |
| 0x94h | R | G | Off | R | Clearing keyboard input buffer |
| 0x95h | R | G | Off | A | Instructing keyboard controller to run Self Test (PS2 only) |
| Mouse (PS2 | - | | | 1 | |
| 0x98h | A | Off | Off | R | Resetting the mouse |
| 0x99h | A | Off | Off | A | Detecting the mouse |
| 0x9Ah | A | Off | G | R | Detecting the presence of mouse |
| 0x9Bh | A | Off | G | A | Enabling the mouse |
| Fixed Media | | r | 1 | r | |
| 0xB0h | R | Off | R | R | Resetting fixed media device |
| 0xB1h | R | Off | R | A | Disabling fixed media device |
| 0xB2h | R | Off | А | R | Detecting presence of a fixed media device (IDE hard drive detection, etc.) |
| 0xB3h | R | Off | Α | Α | Enabling / configuring a fixed media device |
| Removable M | ledia | | 1 | | |
| 0xB8h | Α | Off | R | R | Resetting removable media device |
| 0xB9h | Α | Off | R | Α | Disabling removable media device |
| 0xBAh | А | Off | Α | R | Detecting presence of a removable media device (IDE CDROM detection, etc.) |
| 0xBCh | А | G | R | R | Enabling / configuring a removable media device |
| Boot Device | Selectio | n | l | I | |
| 0xD0 | R | R | Off | R | Trying boot device selection |
| 0xD1 | R | R | Off | Α | Trying boot device selection |
| 0xD2 | R | R | G | R | Trying boot device selection |
| 0xD3 | R | R | G | Α | Trying boot device selection |
| 0xD4 | R | Α | Off | R | Trying boot device selection |
| 0xD5 | R | Α | Off | Α | Trying boot device selection |
| 0xD6 | R | Α | G | R | Trying boot device selection |
| 0xD7 | R | Α | G | Α | Trying boot device selection |
| 0xD8 | A | R | Off | R | Trying boot device selection |
| 0xD9 | A | R | Off | Α | Trying boot device selection |
| 0XDA | A | R | G | R | Trying boot device selection |
| 0xDB | Α | R | G | Α | Trying boot device selection |
| 0xDC | Α | Α | Off | R | Trying boot device selection |
| 0xDE | Α | Α | G | R | Trying boot device selection |
| 0xDF | A | Α | G | Α | Trying boot device selection |
| Pre-EFI Initia | lization | (PEI) Co | ore | | |
| 0xE0h | R | R | R | Off | Started dispatching early initialization modules (PEIM) |
| 0xE2h | R | R | Α | Off | Initial memory found, configured, and installed correctly |

Intel[®] Server Board S5000VCL TPS

Appendix D: POST Code Diagnostic LED Decoder

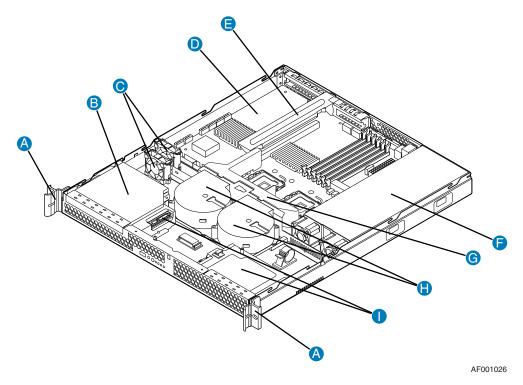
| | Diagr | nostic L | ED Dec | oder | Description | |
|----------------|----------|----------|----------|---------|--|--|
| Checkpoint | G=Gre | en, R=F | Red, A=A | Amber | | |
| | MSB | | | LSB | | |
| 0xE1h | R | R | R | G | Reserved for initialization module use (PEIM) | |
| 0xE3h | R | R | Α | G | Reserved for initialization module use (PEIM) | |
| Driver Execu | tion Env | rironme | nt (DXE |) Core | | |
| 0xE4h | R | Α | R | Off | Entered EFI driver execution phase (DXE) | |
| 0xE5h | R | Α | R | G | Started dispatching drivers | |
| 0xE6h | R | Α | Α | Off | Started connecting drivers | |
| DXE Drivers | | | | | | |
| 0xE7h | R | Α | Α | G | Waiting for user input | |
| 0xE8h | Α | R | R | Off | Checking password | |
| 0xE9h | Α | R | R | G | Entering BIOS setup | |
| 0xEAh | Α | R | Α | Off | Flash Update | |
| 0xEEh | Α | Α | Α | Off | Calling Int 19. One beep unless silent boot is enabled. | |
| 0xEFh | Α | Α | Α | G | Unrecoverable boot failure / S3 resume failure | |
| Runtime Pha | se / EFI | Operati | ng Syst | em Boo | bt | |
| 0xF4h | R | Α | R | R | Entering Sleep state | |
| 0xF5h | R | Α | R | Α | Exiting Sleep state | |
| 0xF8h | A | R | R | R | Operating system has requested EFI to close boot services (ExitBootServices () has been called) | |
| 0xF9h | A | R | R | A | Operating system has switched to virtual address mode (SetVirtualAddressMap () has been called) | |
| 0xFAh | A | R | A | R | Operating system has requested the system to reset (ResetSystem () has been called) | |
| Pre-EFI Initia | lization | Module | (PEIM) | / Recov | /ery | |
| 0x30h | Off | Off | R | R | Crisis recovery has been initiated because of a user request | |
| 0x31h | Off | Off | R | Α | Crisis recovery has been initiated by software (corrupt flash) | |
| 0x34h | Off | G | R | R | Loading crisis recovery capsule | |
| 0x35h | Off | G | R | Α | Handing off control to the crisis recovery capsule | |
| 0x3Fh | G | G | Α | Α | Unable to complete crisis recovery. | |

Appendix E: Supported Intel[®] Server Chassis

The Intel[®] Server Board S5000VCL/S5000VCLR (SATA) is supported in these Intel 1U high density rack mount server systems: Intel[®] Server System SR1530CL/SR1530CLR and Intel[®] Server System SR1530HCL/SR1530HCLR.

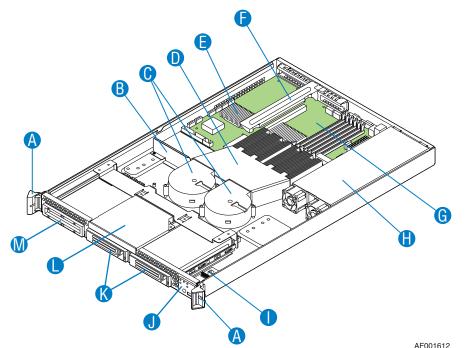
The Intel[®] Server Board S5000VCLSASBB/BBS5000VCLSASR (SAS) is supported in the Intel[®] Server System SR1530HCLS/SR1530HCLSR.

See the Intel[®] Server Systems SR1535CL/SR1530HCL/SR1530HCLS and SR1535CLR/SR1530HCLR/SR1530HCLSR Technical Product Specification for more information.



| А | Rack handles | F | 400 watt power supply |
|---|--|---|---------------------------------------|
| В | Slimline drive bay (drive not included) | G | Processor air duct |
| С | Power supply fans | Н | Fan modules |
| D | Intel [®] Server Board S5000VCL | I | Hard drive bays (drives not included) |
| Е | PCI add-in riser assembly | | |

| Figure 15. Intel [®] Server | System SR1530CL/SR1530CLR |
|--------------------------------------|---------------------------|
|--------------------------------------|---------------------------|



| | | AF001612 |
|--|---|--|
| Rack handles | Н | 400 W power supply |
| Air baffle | Ι | Front panel board |
| Power supply fans | J | Control panel |
| Processor air duct | К | Hard drive bays (drives not included) |
| Full-height PCI riser card | L | Optical drive bay (drive not included) |
| Low-profile PCI riser card | М | Hard drive bay (drive not included) |
| Intel [®] Server Board S5000VCL | | |
| | Air baffle Power supply fans Processor air duct Full-height PCI riser card Low-profile PCI riser card | Air baffleIPower supply fansJProcessor air ductKFull-height PCI riser cardLLow-profile PCI riser cardM |

| Figure 16. Intel [®] | Server System | SR1530HCL/SR1530HCLR |
|-------------------------------|---------------|----------------------|
|-------------------------------|---------------|----------------------|

Glossary

| Term | Definition |
|--------|---|
| ACPI | Advanced Configuration and Power Interface |
| AP | Application Processor |
| APIC | Advanced Programmable Interrupt Control |
| ASIC | Application Specific Integrated Circuit |
| ASMI | Advanced Server Management Interface |
| BIOS | Basic Input/Output System |
| BIST | Built-In Self Test |
| BMC | Baseboard Management Controller |
| Bridge | Circuitry connecting one computer bus to another, allowing an agent on one to access the other |
| BSP | Bootstrap Processor |
| byte | 8-bit quantity. |
| CBC | Chassis Bridge Controller (A microcontroller connected to one or more other CBCs, together they bridge the IPMB buses of multiple chassis. |
| CEK | Common Enabling Kit |
| CHAP | Challenge Handshake Authentication Protocol |
| CMOS | In terms of this specification, this describes the PC-AT compatible region of battery-backed 128 bytes of memory, which normally resides on the server board. |
| DPC | Direct Platform Control |
| EEPROM | Electrically Erasable Programmable Read-Only Memory |
| EHCI | Enhanced Host Controller Interface |
| EMP | Emergency Management Port |
| EPS | External Product Specification |
| ESB2 | Enterprise South Bridge 2 |
| FBD | Fully Buffered DIMM |
| FMB | Flexible Mother Board |
| FRB | Fault Resilient Booting |
| FRU | Field Replaceable Unit |
| FSB | Front Side Bus |
| GB | 1024MB |
| GPIO | General Purpose I/O |
| GTL | Gunning Transceiver Logic |
| HSC | Hot-Swap Controller |
| Hz | Hertz (1 cycle/second) |
| I2C | Inter-Integrated Circuit Bus |
| IA | Intel [®] Architecture |
| IBF | Input Buffer |
| ICH | I/O Controller Hub |
| ICMB | Intelligent Chassis Management Bus |
| IERR | Internal Error |
| IFB | I/O and Firmware Bridge |
| INTR | Interrupt |
| IP | Internet Protocol |

Intel[®] Server Board S5000VCL TPS

Intelligent Platform Management Bus

Term

IPMB

Glossary

| | Intelligent Hattorn Management Bus |
|---------|--|
| IPMI | Intelligent Platform Management Interface |
| IR | Infrared |
| ITP | In-Target Probe |
| KB | 1024 bytes |
| KCS | Keyboard Controller Style |
| LAN | Local Area Network |
| LCD | Liquid Crystal Display |
| LED | Light Emitting Diode |
| LPC | Low Pin Count |
| LUN | Logical Unit Number |
| MAC | Media Access Control |
| MB | 1024KB |
| MCH | Memory Controller Hub |
| MD2 | Message Digest 2 – Hashing Algorithm |
| MD5 | Message Digest 5 – Hashing Algorithm – Higher Security |
| ms | milliseconds |
| MTTR | Memory Type Range Register |
| Mux | Multiplexor |
| NIC | Network Interface Controller |
| NMI | Nonmaskable Interrupt |
| OBF | Output Buffer |
| OEM | Original Equipment Manufacturer |
| Ohm | Unit of electrical resistance |
| PEF | Platform Event Filtering |
| PEP | Platform Event Paging |
| PIA | Platform Information Area (This feature configures the firmware for the platform hardware) |
| PLD | Programmable Logic Device |
| PMI | Platform Management Interrupt |
| POST | Power-On Self Test |
| PSMI | Power Supply Management Interface |
| PWM | Pulse-Width Modulation |
| RAM | Random Access Memory |
| RASUM | Reliability, Availability, Serviceability, Usability, and Manageability |
| RISC | Reduced Instruction Set Computing |
| ROM | Read Only Memory |
| RTC | Real-Time Clock (Component of ICH peripheral chip on the server board) |
| SDR | Sensor Data Record |
| SECC | Single Edge Connector Cartridge |
| SEEPROM | Serial Electrically Erasable Programmable Read-Only Memory |
| SEL | System Event Log |
| SIO | Server Input/Output |
| SMI | Server Management Interrupt (SMI is the highest priority nonmaskable interrupt) |
| SMM | Server Management Mode |

Definition

Glossary

Intel[®] Server Board S5000VCL TPS

| Term | Definition |
|------|---|
| SNMP | Simple Network Management Protocol |
| TBD | To Be Determined |
| TIM | Thermal Interface Material |
| UART | Universal Asynchronous Receiver/Transmitter |
| UDP | User Datagram Protocol |
| UHCI | Universal Host Controller Interface |
| UTC | Universal time coordinare |
| VID | Voltage Identification |
| VRD | Voltage Regulator Down |
| Word | 16-bit quantity |
| ZIF | Zero Insertion Force |

Reference Documents

Reference Documents

• Intel[®] 5000 Series Chipsets Server Board Family Datasheet